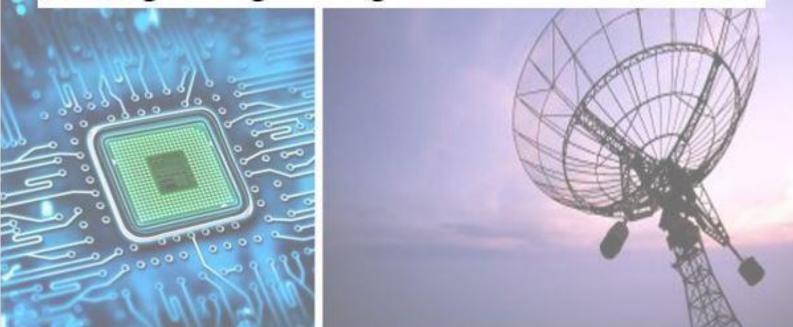


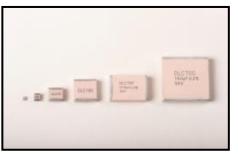
RF & MICROWAVE COMPONENTS







Passive Plus, Inc. (PPI) specializes in Magnetic & Non-Magnetic HI-Q Components, supplying reliable quality components to the Aerospace, Telecommunications, Medical Semiconductor, and Military industries.



Marking shown for illustration purposes only. Actual marking may differ.

PPI is an American (New York), Woman owned Business.

- PPI is ISO9001:2015 certified.
- S level reliability
- Mil C 55681
- Mil C 123
- EAR 99 Compliant
- No ITAR Issues
- Export Compliant
- RoHS and REACH Compliant

PPI has been audited by some of the largest and most successful companies in the world and has received extremely high audit ratings. We believe our audit ratings are best in class. PPI is known for Outstanding Customer Service and RF Engineering Support.





Marking shown for illustration purposes only.

Actual marking may differ.

Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance

+ Product Applications

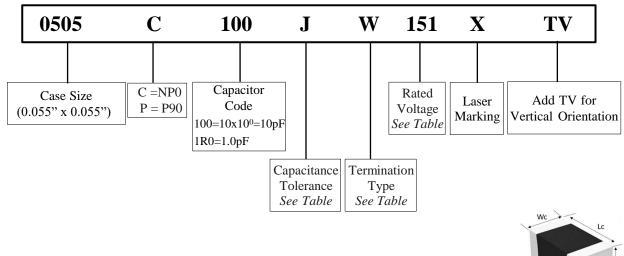
Typical Functional Applications:

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications:

- UHF/Microwave RF Power Amplifiers •
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines





Case Size (Chip) Dimensions

| | 0505 | 1111 | 2225 | 3838 | 6040 | 7676 |
|-----------------------------|--|---|---|--|--|---|
| Length (L _c) | 0.055 + 0.015 to -0.010 (1.40 +0.38 to -0.25) | 0.110 + 0.020 to -0.010 (2.79 +0.51 to -0.25) | 0.225 -0.010+0.25 (5.72 -0.25+ 0.64) | 0.380 -0.010+0.015 (9.65 -0.25+0.38) | 0.614 -0.010+0.015 (15.6 -0.25+0.38) | 0.760 -0.010+0.015 (19.3 -0.25+0.38) |
| Width (W _c) | 0.055 ± .010 (1.40 ±0.25) | $\begin{array}{c} 0.110 \pm 0.010 \\ (2.79 \pm 0.25) \end{array}$ | $\begin{array}{c} 0.250 \pm 0.015 \\ (6.35 \pm 0.38) \end{array}$ | 0.380 ± 0.010 (9.65±0.25) | 0.433±0.010 (11.0±0.25) | 0.760±0.010 (19.3±0.25) |
| Thickness (T _c) | 0.057 (1.45 max) | 0.10 (2.54 max) | 0.165 (4.19) max | 0.170 (4.32) max | 0.154±0.008 (3.90±0.20) max | 0.154±0.008 (3.90±0.20) max |
| Overlap (B) | 0.02 (0.51max) | 0.024 (0.60max) | 0.020~0.047 (0.50~1.20) max | 0.024~0.059 (0.60~1.50) | 0.063 (1.60) max | 0.063 (1.60) max |



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† Temperature Coefficient

C: -55°C to 125°C 0±30ppm/°C; >125 °C to 200°C 0±60ppm/°C P: +90±20ppm/°C

Rated Capacitance

Capacitance is less than 10pF; for example: 1R0=1.0pF, R denotes decimal point Capacitance greater than 10pF; for example: 101=100pF, the third number is the power of 10

† Tolerance

| | Capacitance Tolerance | | | | | | | | | |
|-----------|-----------------------|--------|---------|--------|-----|-----|-----|------|--|--|
| Code | А | В | С | D | F | G | J | K | | |
| Tolerance | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% | | |

Formination Types and Codes

| | | Magnetic | | | \bigotimes | Non-Magne | tic 🔗 |
|-----------------|------|---------------|---------------------------------------|-----------------|--------------|---------------|---------------------------------------|
| Termina Code | | Туре | Magnetic Termination | Termina Code | | Туре | Non-Magnetic Terminations |
| W | RoHS | Chip | 100% Sn Solder over Nickel Plating | Р | RoHS | Chip | 100% Sn Solder over Copper Plating |
| L | | Chip | 90% Sn10%Pb Tin/Lead Solder | MN | ROHS | Microstrip | |
| | | - | over Nickel Plating | AN | ROHS | Axial Ribbon | – Silver-Plated |
| MS | RoHS | Microstrip | | FN | ROHS | Radial Ribbon | Copper |
| AR | RoHS | Axial Ribbon | - 1 | RN | ROHS | Axial Wire | - |
| RR | RoHS | Radial Ribbon | Silver-Plated Copper | BN | ROHS | Radial Wire | _ |
| RW | RoHS | Axial Wire | | | | | _ |
| AW | RoHS | Radial Wire | | | | | |



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÷ Voltages

| Code | Rated Voltage | Code | Rated Voltage |
|------|----------------------|------|----------------------|
| 500 | 50V | 152 | 1500V |
| 101 | 100V | 202 | 2000V |
| 151 | 150V | 252 | 2500V |
| 201 | 200V | 302 | 3000V |
| 301 | 300V | 362 | 3600V |
| 501 | 500V | 502 | 5000V |
| 102 | 1000V | 722 | 7200V |

‡ Laser Marking

An "X" at the end of the part number indicates the part is marked.

Packing Orientation Option

TV: Tape carrier packaging Vertical Orientation.

Vertical orientation means that if the part is lifted from the tape without any rotation and placed on a substrate, its electrodes will be perpendicular to the substrate plane. This impacts the frequency of First Parallel Resonance (suckout).

Performance Requirements

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

All products are in compliance with RoHS instruction.



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0505C/P (0.055" x 0.055")

Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 1000pF
- Working Voltage: 150V
- Extended Voltage: 300V

Part Numbering

F **Product Applications**

Typical Functional Applications:

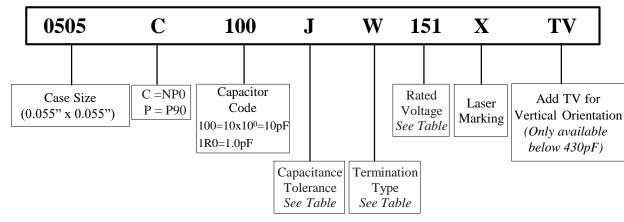
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications:

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits
- and Delay Lines



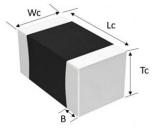
Marking shown for illustration purposes only. Actual marking may differ.



Capacitor Dimensions

Unit: inch (millimeter)

| Length | Width | Thickness | Overlap |
|--|--|---------------------|--------------------|
| Lc | Wc | Тс | В |
| 0.055 + 0.015 to -0.010 (1.40 +0.38 to -0.25) | $\begin{array}{c} 0.055 \pm .010 \\ (1.40 \pm 0.25) \end{array}$ | 0.057 (1.45 max) | 0.020 (0.51max) |



Temperature Coefficient

- **C**: -55° to 125° C 0 ± 30 ppm/°C;
 - $>125^{\circ}C$ to $200^{\circ}C$ 0 ± 60 ppm/ $^{\circ}C$
- **P**: ±90 ±20ppm/°C

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0505C/P (0.055" x 0.055")

≠ 0505C/P Capacitance Values

- NP0=C; P90=P
- Maximum Capacitance: 0505P=100pF; 0505C=1000pF
- * Available in NP0 only.

Special capacitances, tolerances and WVDC are available. Please contact PPI.



| Cap. | Сар | | Rated | WVDC | Cap. | Cap | | Rated | WVDC | Cap. | Cap | | Rated | WVDC | Cap. | Сар | | Rated | WVDC | | | | | | |
|------|------|------|-------|------|------|------|-------------|-------|------------|------|------|------|-------|-------|------|------|-------------|-------|------|--|-----|------|--|--|--|
| pF | Code | Tol. | Std. | Ext. | pF | Code | Tol. | Std. | Ext. | pF | Code | Tol. | Std. | Ext. | pF | Code | Tol. | Std. | Ext. | | | | | | |
| 0.1 | 0R1 | | | | 2.4 | 2R4 | | | | 20 | 200 | | | | 160 | 161* | | | | | | | | | |
| 0.2 | OR2 | | | | 2.7 | 2R7 | | | | 22 | 220 | | | | 180 | 181* | | | | | | | | | |
| 0.3 | OR3 | | | | 3.0 | 3R0 | | | | 24 | 240 | | | | 200 | 201* | | | | | | | | | |
| 0.4 | 0R4 | | | | 3.3 | 3R3 | | | | 27 | 270 | | | | 220 | 221* | F,G, | 150V | 200V | | | | | | |
| 0.5 | OR5 | | | | 3.6 | 3R6 | | | | 30 | 300 | F,G, | | 250V | 240 | 241* | J,K | | | | | | | | |
| 0.6 | OR6 | | | | 3.9 | 3R9 | | | | 33 | 330 | J,K | 150V | or | 270 | 271* | | | | | | | | | |
| 0.0 | OR7 | | | | 4.3 | 4R3 | | | 0.5 O. I | 36 | 360 | | | 300V | 300 | 301* | | | | | | | | | |
| | 0R7 | | | | | - | А,В, | 150V | 250V or | | | | | | | 331* | | | | | | | | | |
| 0.8 | | | | | 4.7 | 4R7 | C,D | 1300 | 300V | 39 | 390 | | | | 330 | | | | | | | | | | |
| 0.9 | 0R9 | | | | 5.1 | 5R1 | | | | | | | | | | 43 | 430 | | | | 360 | 361* | | | |
| 1.0 | 1R0 | | | 250V | 5.6 | 5R6 | | | | 47 | 470 | | | | 390 | 391* | | | | | | | | | |
| 1.1 | 1R1 | A,B, | 150V | or | 6.2 | 6R2 | | | | 51 | 510 | | | | 430 | 431* | F,G, J,K | 150V | N/A | | | | | | |
| 1.2 | 1R2 | C,D | | 300V | 6.8 | 6R8 | | | | 56 | 560 | | | | 470 | 471* | J,K | | | | | | | | |
| 1.3 | 1R3 | | | | 7.5 | 7R5 | | | | 62 | 620 | | | | 510 | 511* | | | | | | | | | |
| 1.4 | 1R4 | | | | 8.2 | 8R2 | | | | 68 | 680 | | | | 560 | 561* | | | | | | | | | |
| 1.5 | 1R5 | | | | 9.1 | 9R1 | | | | 75 | 750 | | | | 620 | 621* | | | | | | | | | |
| 1.6 | 1R6 | | | | 10 | 100 | | | | 82 | 820 | F,G, | 150V | 200V | 680 | 681* | | | | | | | | | |
| 1.7 | 1R7 | | | | 11 | 110 | | | | 91 | 910 | J,K | 1500 | 200 V | 750 | 751* | | | | | | | | | |
| 1.8 | 1R8 | | | | 12 | 120 | | | 250V | 100 | 101 | | | | 820 | 821* | F,G, J,K | 50V | 100V | | | | | | |
| 1.9 | 1R9 | | | | 13 | 130 | F,G, J,K | 150V | or | 110 | 111* | | | | 910 | 911* | <u>ј,</u> к | | | | | | | | |
| 2.0 | 2R0 | | | | 15 | 150 |),К | | 300V | 120 | 121* | | | | 1000 | 102* | | | | | | | | | |
| 2.1 | 2R1 | | | | 16 | 160 | | | | 130 | 131* | | | | | | | | | | | | | | |
| 2.2 | 2R2 | | | | 18 | 180 | | | | 150 | 151* | | | | | | | | | | | | | | |

*Available in NP0 only





0505C/P (0.055" x 0.055")

‡ Capacitance Tolerance Codes

| Code | Α | В | С | D | F | G | J | K |
|------|---------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |

† Termination Types

| Termination Code | | Termination | |
|-------------------------|--------------|---------------------------------------|------|
| W | | 100% Sn | - |
| | | Solder over Nickel Plating | RoHS |
| | | 90% Sn10%Pb | |
| \mathbf{L} | | Tin/Lead | |
| | | Solder over Nickel Plating | |
| P (Non-Magnetic) | \bigotimes | 100% Sn Solder over Copper Plating | RoHS |

Note: "Non-Magnetic" means no magnetic materials.

Voltage Codes

| Voltage | Code |
|---------|------|
| 50V | 500 |
| 100V | 101 |
| 150V | 151 |
| 200V | 201 |
| 250V | 251 |
| 300V | 301 |







0505C/P (0.055" x 0.055")

÷ Electrical Specifications

| Quality Factor (Q) | Greater than 10,000 at 1 MHz |
|--|---|
| Insulation Resistance (IR) | 10 ⁵ MegaOhms min. @ +25°C rated WVDC 10 ⁴ MegaOhms min. @ +125°C rated WVDC |
| Rated Voltage | See Rated Voltage Table |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds |
| Operating Temperature Range | -55°C to 200°C |
| Temperature Coefficient (TC) | C: -55°C to 125°C 0±30ppm/°C; >125°C to 200°C 0±60ppm/°C P: +90±20ppm/°C |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater |
| Piezoelectric Effects | None |
| Termination Type | See Termination Type Table |

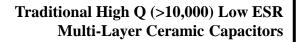
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

÷ Environmental Specifications

| | Specification | Test Parameters |
|----------------------------|--|--|
| Thermal Shock | DWV: The initial Value IR: Shall not be less than 30% of the initial value. Capacitance Change: | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Moisture Resistance | No more than 0.5% or 0.5pF, whichever is greater. | MIL-STD-202, Method 106 |
| Humidity (Steady State) | DWV: The initial Value IR: The initial value. Capacitance Change: No more than 0.5% or 0.5pF, whichever is greater. | MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater. | MIL-STD-202, Method 108. For 2000 hours, at 200°C. Rated Voltage DC applies. |
| Terminal Strength | Force: 10lbs typical, 5lbs. Minimum. Duration Time: 5 to 10 seconds | MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations. |



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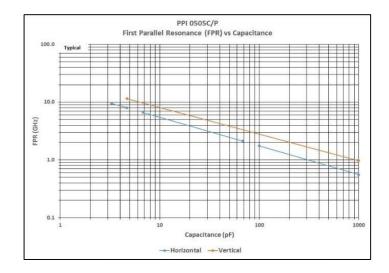
0505C/P (0.055" x 0.055")

FPR -- First Parallel Resonance (FPRs)

Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|.

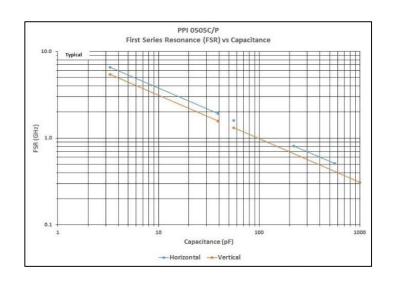
It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.



FSR -- First Series Resonance (FSRs)

† Definitions and Measurement Conditions

The First Series Resonance, FSR, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent internal capacitor on structure: substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.



The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.66; horizontal mount substrate thickness (mils) =25; gap in microstrip trace (mils) = 15; horizontal mount microstrip trace width (mils) = 55. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



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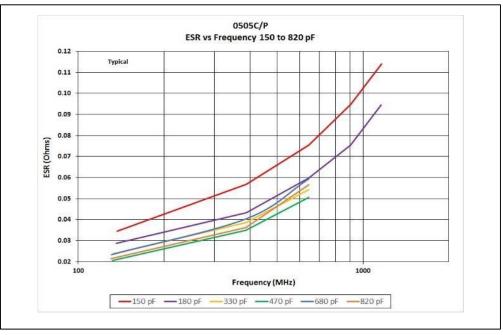
0505C/P (0.055" x 0.055")

≠ ESR vs. Frequency



0505C/P ESR vs Frequency

0505C ESR vs Frequency





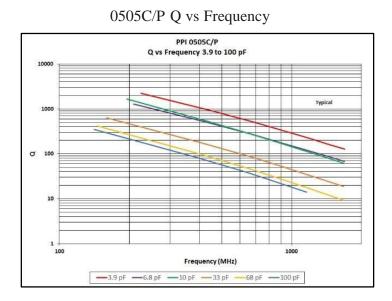
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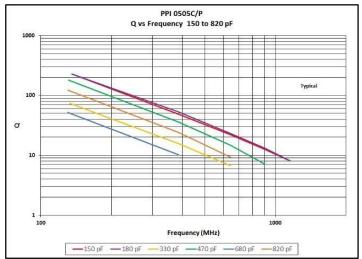


0505C/P (0.055" x 0.055")

‡ Q vs. Frequency

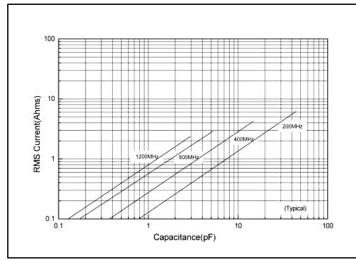


0505C Q vs Frequency



÷ Current Rating vs. Capacitance

0505C/P Current Rating vs Capacitance

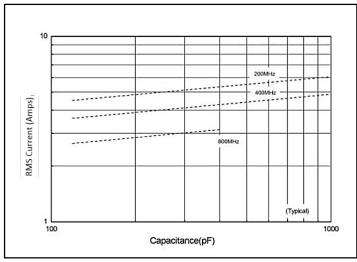


The current depends on voltage limited:

$$I = \frac{\sqrt{2}}{2} I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_c} = \sqrt{2} \pi d^2 C V_{rated}$$

The current depends on power dissipation limited: $I = \sqrt{\frac{I \text{ dissipation}}{ESR}}$

0505C Current Rating vs Capacitance



Note: If the thermal resistance of mounting surface is 40° C/W. then a power dissipation of 1.5 W will result in the current limited we can calculate the current limited:

$$I = \sqrt{\frac{P_{dissipation}}{ESR}}$$

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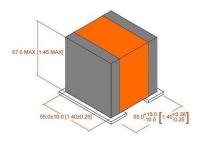
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0505C/P (0.055" x 0.055")

Capacitor Application Program

Passive Plus, Inc.'s brand new **online Capacitor Application Program** (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models, by either visiting the <u>Passive Plus Resources page</u> (http://passiveplus.com/addldocs_resources.php).





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0505C/P (0.055" x 0.055"

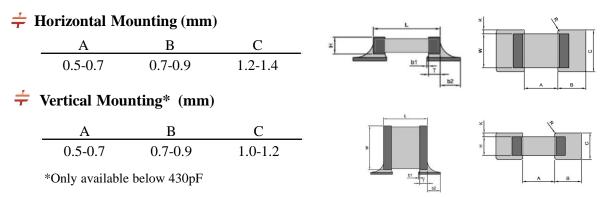
Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

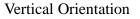
2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device

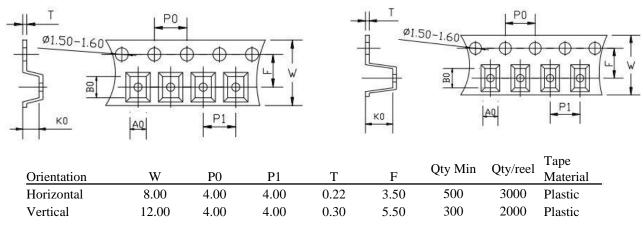
into exclusive pads by using soldering resist.



Tape & Reel Specifications (mm)

Horizontal Orientation





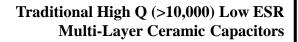
$A_0 B_0 K_0$

• Determined by component size. Typical clearance between the cavity and the component is: .05 (.002) min to .50 (.020) max for 8mm tape and .50 (.002) min to .65 (.026) max for 12mm tape.

• The component cannot rotate more than 20° within the determined cavity.



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0505C/P (0.055" x 0.055")



† Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are offered in Magnetic or Non-Magnetic Terminations. Kits are 100% RoHS compliant.

| Kit N | umber | Value | Values | | |
|----------------|--------------|--------------|---|--------|--|
| MAGNETIC | NON-MAGNETIC | Range | v alues | | |
| DKD0505C01 | DKD0505C05 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF | - | |
| DKD0505P01 | DKD0505P05 | 0.1 - 2.0рг | 0.1, 0.2, 0.3, 0.4, 0.5, 0.0, 0.7, 0.6, 0.7, 1.0, 1.2, 1.5, 1.6, 1.6, 2.0pr | RoHS | |
| DKD0505C02 | DKD0505C06 | 1 10mE | 10 1 2 1 5 1 8 20 22 24 27 20 22 20 47 56 68 82 10mE | | |
| DKD0505P02 | DKD0505P06 | 1 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF | RoHS | |
| DKD0505C03 | DKD0505C07 | 10 100mE | 10 12 15 18 20 22 24 27 20 22 20 47 56 68 82 100mE | | |
| DKD0505P03 | DKD0505P07 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF | RoHS | |
| DKD0505C04 | DKD0505C08 | 100 - 1000pF | 100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 100 |)0pF 🚮 | |





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11111C/P (0.110" x 0.110")

Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance •
- Ultra Stable Performance •
- Capacitance Range: • 0.1pF to 10000pF
- Working Voltage: 500V
- Extended Voltage: 1500V •

Part Numbering

Froduct Applications

Typical Functional Applications

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

and Delay Lines

Typical Circuit Applications

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits



Marking shown for illustration purposes only. Actual marking may differ.

С J 1111 100 W 501 X TV C=NP0 Capacitor Add TV for Rated Case Size Laser P=P90 Code Vertical Voltage (.110" x .110") Marking 100=10x10⁰=10pF See Table Orientation 1R0=1.0pF Capacitance Termination Tolerance Туре See Table See Table

Capacitance Tolerance Codes

| Code | Α | В | С | D | F | G | J | K |
|------|---------------|--------|---------|--------|-----|-----|-----|------|
| Tol. | $\pm 0.05 pF$ | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |

| Voltage Codes | Voltage | Code |
|---------------|---------|------|
| | 50V | 500 |
| | 100V | 101 |
| | 200V | 201 |
| | 300V | 301 |
| | 500V | 501 |
| | 600V | 601 |
| | 1000V | 102 |
| | 1500V | 152 |



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11111C/P (0.110" x 0.110")

1111C/P Capacitance Values

- NP0=C; P90=P
- Maximum Capacitance: 1111P=1000pF; 1111C=10000pF
- * Available in NP0 only.

Special capacitances, tolerances and WVDC are available. Please contact PPI.



Marking shown for illustration purposes only. Actual marking may differ.

| Cap. | Сар | | Rated \ | WVDC | Cap. | Сар | | Rated | WVDC | Cap. | Сар | | Rated | WVDC | Cap. | Сар | | Rated \ | <u>WVDC</u> | |
|------|------|---------------|---------|---------------------------|------|------|--------------|-------|-------------|------|------|-------------|-------|-------------|------|-------|------|---------|-------------|--|
| pF | Code | Tol. | Std. | Ext. | рF | Code | Tol. | Std. | Ext. | рF | Code | Tol. | Std. | Ext. | рF | Code | Tol. | Std. | Ext. | |
| 0.1 | OR1 | | | 400014 | 3.3 | 3R3 | | | | 36 | 360 | | | | 390 | 391 | F,G, | | | |
| 0.2 | OR2 | A,B | 500V | 1000V 500V or 1500V | 3.6 | 3R6 | | | | 39 | 390 | | | | 430 | 431 | J,K | 200V | 600V | |
| 0.3 | OR3 | ,- | | | 3.9 | 3R9 | | | | 43 | 430 | | | | 470 | 471 | , | | | |
| 0.4 | 0R4 | | | | 4.3 | 4R3 | | | | 47 | 470 | | | | 510 | 511 | | | | |
| 0.5 | OR5 | | | | 4.7 | 4R7 | | | 40001 | 51 | 510 | | | 400014 | 560 | 561 | | | | |
| 0.6 | OR6 | | | | 5.1 | 5R1 | A,B | 500V | 1000V or | 56 | 560 | F,G, 500 | 500V | 1000V or | 620 | 621 | | | | |
| 0.7 | 0R7 | | | | 5.6 | 5R6 | C,D | 5001 | 1500V | 62 | 620 | J,K | 5001 | 1500V | 680 | 681 | F,G, | 100V | 200V | |
| 0.8 | OR8 | | | | 6.2 | 6R2 | | | 68 | 680 | | | | 750 | 751 | J,K | 1001 | 2001 | | |
| 0.9 | OR9 | | | | 6.8 | 6R8 | | | | 75 | 750 | | | | 820 | 821 | | | | |
| 1.0 | 1R0 | | | | 7.5 | 7R5 | | | | 82 | 820 | | | | 910 | 911 | | | | |
| 1.1 | 1R1 | | | | 8.2 | 8R2 | | | | 91 | 910 | | | | 1000 | 102 | | | | |
| 1.2 | 1R2 | | | | 9.1 | 9R1 | | | | 100 | 101 | | | | 1100 | 112* | | | | |
| 1.3 | 1R3 | | | 1000V | 10 | 100 | | | | 110 | 111 | | | | 1200 | 122* | F,G, | 200V | N/A | |
| 1.4 | 1R4 | А,В, | | | 11 | 110 | | | | 120 | 121 | 5.6 | | | 1500 | 152* | J,K | 2001 | , | |
| 1.5 | 1R5 | д, в, С, D | 500V | or | 12 | 120 | | | | 130 | 131 | | | 300V 1000V | 1800 | 182* | F,G, | | | |
| 1.6 | 1R6 | | | 1500V | 13 | 130 | | | | 150 | 151 | F,G, J,K | 300V | | 2000 | 202* | | | | |
| 1.7 | 1R7 | | | | 15 | 150 | | | | 160 | 161 | | | | 2200 | 222* | | | | |
| 1.8 | 1R8 | | | | 16 | 160 | F,G, | | 1000V | 180 | 181 | | | | 2700 | 272* | | | | |
| 1.9 | 1R9 | | | | 18 | 180 | г, G, J,K | 500V | or | 200 | 201 | | | | 3000 | 302* | J,K | 100V | N/A | |
| 2.0 | 2R0 | | | | 20 | 200 | | | 1500V | 220 | 221 | | | | 3300 | 332* | | | | |
| 2.1 | 2R1 | | | | 22 | 220 | | | | 240 | 241 | | | | 4700 | 472* | | | | |
| 2.2 | 2R2 | | | | 24 | 240 | | | | 270 | 271 | F,G, | 200V | 600V | 5100 | 512* | | | | |
| 2.4 | 2R4 | | | | 27 | 270 | | | | 300 | 301 | J,K | 2007 | 0001 | 5600 | 562* | F,G, | 50V | N/A | |
| 2.7 | 2R7 | | | | | 30 | 300 | | | | 330 | 331 | | | | 10000 | 103* | J,K | | |
| 3.0 | 3R0 | | | | 33 | 330 | | | | 360 | 361 | | | | | | | | | |

*Available in NP0 only



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| Tern | nination | s Types and Code | es | | | Magn | etic 7 | Terminations | |
|------|--------------------|---|---|--------------------|-------------------|---------------|----------|--|---------------------------------------|
| | | | | , | Terminat Code | ion | | Terminat | ion |
| | WC | , T | | | W | RoHS | So | 100% S Ider over Nick | |
| | | τ. τ. | u u | | L | | So | 90% Sn10 Tin/Lea Ider over Nick | d |
| - | Terminat | | on: | MS | ROHS | | 100% Sil | ver | |
| Code | es: W, L, | P Codes: N | AS, MIN | | 🔗 I | Non-Mag | gneti | c Terminatio | ns 🔗 |
| | | | | | Р | RoHS | Sol | 100%Si Ider over Copj | |
| | | | | | MN | ROHS | | 100% Sil | ver |
| Caj | pacitor D | Dimensions Unit: in | nch (millimeter) | | | | | | |
| | | | | etic Termina | ations | | | | |
| | | | pacitor Dime | | | | | Lead Dimensi | |
| Code | Term. | Length | Width | Thickness | Overla | p Len | gth | Width | Thickness |
| | | Lc | Wc | Tc | В | L | Ĺ | WL | TL |
| W/L | Chip | 0.110 + 0.020 to -0.010 (2.79 +0.51 to -0.25) | $\begin{array}{c} 0.110 \pm 0.010 \\ (2.79 \pm 0.25) \end{array}$ | 0.10 (2.54 max) | 0.024 (0.60ma: | x) - | | - | - |
| MS | Microstrip | $\begin{array}{c} 0.135 \pm 0.015 \\ (3.43 \pm 0.38) \end{array}$ | $\begin{array}{c} 0.110 \pm 0.010 \\ (2.79 \pm 0.25) \end{array}$ | 0.10 (2.54 max) | - | 0.2 (6.35) | | $\begin{array}{c} 0.093 \pm \! 0.005 \\ (2.36 \pm 0.13) \end{array}$ | |
| | | | 🗭 Non-Mag | gnetic Term | inations | \bigotimes | | | |
| Code | Term. | Length | Width | Thickness | Overla | p Len | gth | Width | Thickness |
| | | Lc | Wc | Тс | В | L | Ĺ | WL | TL |
| Р | Chip | 0.110 + 0.020 to -0.010 (2.79 +0.51 to -0.25) | $\begin{array}{c} 0.110 \pm 0.010 \\ (2.79 \pm 0.25) \end{array}$ | 0.10 (2.54 max) | 0.024 (0.60ma | x) | | - | - |
| MN | Microstrip Non- | $0.135 \pm 0.015 \\ (3.43 \pm 0.38)$ | 0.110 ± 0.010 (2.79 ±0.25) | 0.10 (2.54 max) | - | 0.2 | | $\begin{array}{c} 0.093 \pm 0.005 \\ (2.36 \pm 0.13) \end{array}$ | 0.004 ± 0.00 (0.10 ± 0.13) |





1111C/P (0.110" x 0.110")

Electrical Specifications

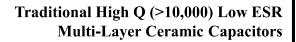
| Quality Factor (Q) | Greater than 10,000 at 1 MHz |
|--|--|
| Insulation Resistance (IR) | 0.1pF to 470pF: 10° Megaohms min. @ +25°C rated WVDC 10⁵ Megaohms min. @ +125°C rated WVDC 510pF to 1000pF: 10⁵ Megaohms min. @ +25°C rated WVDC 10⁴ Megaohms min. @ +125°C rated WVDC |
| Rated Voltage | See Rated Voltage Table |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 1250="" vdc<br="" voltage="" ≤="">120% of Voltage for 5 seconds, Rated Voltage > 1250 VDC</rated> |
| Operating Temperature Range | -55°C to 200°C |
| Temperature Coefficient (TC) | C: -55°C to 125°C 0±30ppm/°C; >125°C to 200°C 0±60ppm/°C P: +90±20ppm/°C |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater |
| Piezoelectric Effects | None |
| Termination Type | See Termination Type Table |

÷ Environmental Specifications

| | Specification | Test Parameters |
|----------------------------|--|--|
| Thermal Shock | DWV: The initial Value IR: Shall not be less than 30% of the initial value. Capacitance Change: | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Moisture Resistance | No more than 0.5% or 0.5pF, whichever is greater. | MIL-STD-202, Method 106 |
| Humidity (Steady State) | DWV: The initial Value IR: The initial value. Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater. | MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater. | MIL-STD-202, Method 108. For 2000 hours, at 200°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC |
| Terminal Strength | Force: 10lbs typical, 5lbs. Minimum. Duration Time: 5 to 10 seconds | MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations. |

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.





茾 FPR -- First Parallel Resonance (FPRs)

Definitions and Measurement Conditions

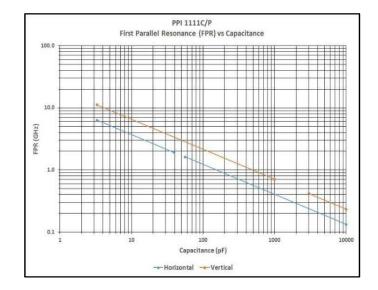
The First Parallel Resonance, FPR, is defined as the lowest frequency at which a suckout or notch appears in [S21].

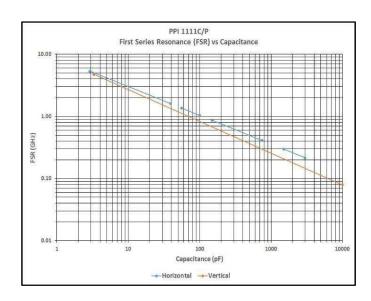
It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.

FSR --- First Series Resonance (FSRs)

Definitions and Measurement Conditions

The First Series Resonance, FSR, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] = 0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR dependent on internal capacitor is substrate thickness and dielectric structure: constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.





The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.66; horizontal mount substrate thickness (mils) = 50; gap in microstrip trace (mils) = 72; horizontal mount microstrip trace width (mils) = 110. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.





1111C/P (0.110" x 0.110")

🗧 ESR vs. Frequency

1111C/P ESR vs Frequency



1111C ESR vs Frequency



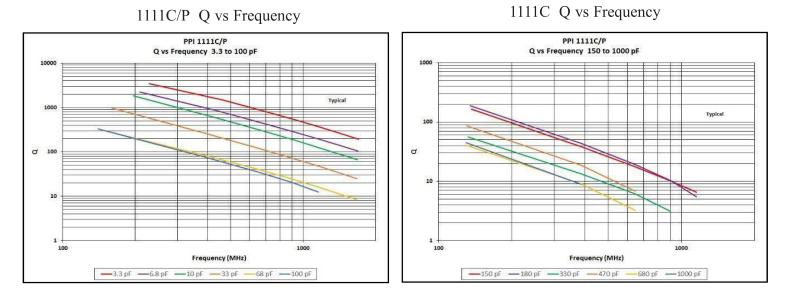


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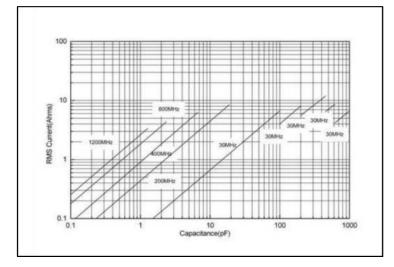
1111C/P (0.110" x 0.110")

茾 Q vs. Capacitance



+ Current Rating vs. Capacitance

1111C/P Current Rating vs Capacitance

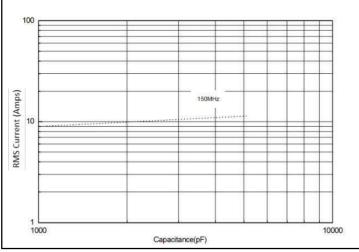


The current depends on voltage limited: $I = \frac{\sqrt{2}}{2} I_{pook} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_c} = \sqrt{2} \pi F C V_{rated}$ $I = \sqrt{\frac{P_{abssipation}}{ESR}}$

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The current depends on power dissipation limited:

1111C Current Rating vs Capacitance



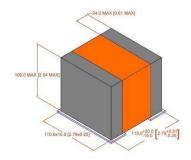
Note: If the thermal resistance of mounting surface is 20°C/W. then a power dissipation of 3 W will result in the current limited we can calculate the current limited: $I = \sqrt{\frac{P_{supports}}{ESR}}$





븆 Capacitor Application Program

Passive Plus, Inc.'s brand new **online Capacitor Application Program** (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models, by either visiting the <u>Passive Plus Resources page</u> (<u>http://passiveplus.com/addldocs_resources.php</u>).

#Modelithics®



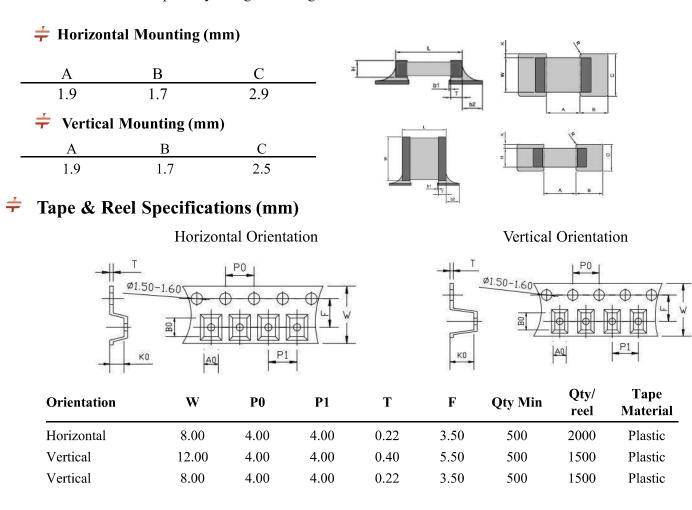


Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.



$A_0 B_0 K_0$

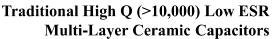
- Determined by component size. Typical clearance between the cavity and the component is: .05 (.002) min to .50 (.020) max for 8mm tape and .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

Dimensions: mm

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Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are offered in Magnetic or Non-Magnetic Terminations. Kits are 100% RoHS com liant.

| Value | Values |
|---------------------|---|
| IAGNETIC Range | values |
| D1111C05 1.0 10m | F 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF |
| D1111P05 | F 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9 , 4.7 , 5.6 , 6.8 , 8.2 , $10pF$ |
| 01111C06 10 100m | E 10 12 15 18 20 22 24 27 20 22 20 47 56 68 82 100mE |
| D1111P06 | F 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF |
| D1111C07 100 1000- | b 100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, |
| D1111P07 | 1000pF Roms |
| 01111C08 1000 10000 | 1000 , 1100, 1200, 1500, 1800, 2000, 2200, 2700, 3000, 3300, 3900, 4700, |
| D1111P08 | 5100, 5600, 10000pF |
| | IAGNETIC Range 01111C05 1.0 - 10pl 01111P05 10 - 100pl 01111C06 10 - 100pl 01111C07 100 - 1000pl 01111C08 1000 - 1000pl |

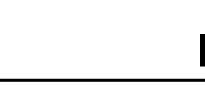




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PPI1111CPDATA070122RevA







2225C/P (0.220" x 0.250")

F Product Features

- High Q •
- High RF Current/Voltage
- Ultra Stable Performance •
- Capacitance Range: 0.5pF to 2700pF
- Working Voltage: 2500V
- Extended Voltage: 3600V

\neq Product Applications

Typical Functional Applications:

- Tuning Bypass Coupling
- D.C. Blocking Impedance Matching

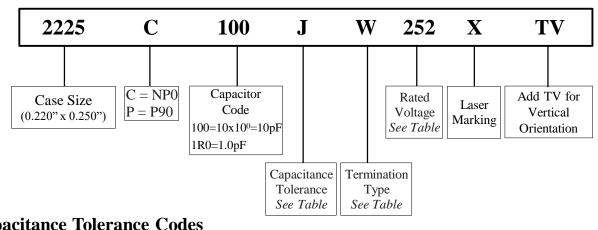
Typical Circuit Applications

- UHF/Microwave RF Power Amplifiers
- Antenna Tuning Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only. Actual marking may differ.

茾 Part Numbering



† Capacitance Tolerance Codes

| Code | Α | В | С | D | F | G | J | K |
|------|---------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |

† Voltage Codes

| Voltage | Code |
|---------|------|
| 500V | 501 |
| 1000V | 102 |
| 1500V | 152 |
| 2000V | 202 |
| 2500V | 252 |
| 3000V | 302 |
| 3600V | 362 |
| | |



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2225C/P (0.220" x 0.250")

† 2225C/P Capacitance Values

• NP0=C; P90=P

Special capacitances, tolerances and WVDC are available. Please contact PPI.



| Cap. | Сар | T -1 | Rated | WVDC | Cap. | Сар | T -1 | Rated WVD | Cap. | Сар | T - 1 | Rated | WVDC | Cap. | Сар | T - 1 | Rated | WVDC |
|------|------|-------------|--------|-------|------|------|-------------|------------|-------|------|--------------|--------|-------|------|------|--------------|--------|--------|
| рF | Code | Tol. | Std. | Ext. | pF | Code | Tol. | Std. Ext. | pF | Code | Tol. | Std. | Ext. | рF | Code | Tol. | Std. | Ext. |
| 0.5 | OR5 | | | | 4.3 | 4R3 | | | 43 | 430 | | | | 430 | 431 | F,G, | 15001/ | 2000V |
| 0.6 | OR6 | | | | 4.7 | 4R7 | | | 47 | 470 | | | | 470 | 471 | J,K | 13000 | 2000 V |
| 0.7 | OR7 | | | | 5.1 | 5R1 | | | 51 | 510 | | | | 510 | 511 | | | |
| 0.8 | OR8 | | | | 5.6 | 5R6 | | | 56 | 560 | | | | 560 | 561 | | | |
| 0.9 | OR9 | | | | 6.2 | 6R2 | B,C, D | 2500V 3600 | V 62 | 620 | F,G, | 25001/ | 3600V | 620 | 621 | | | |
| 1.0 | 1R0 | | | | 6.8 | 6R8 | | | 68 | 680 | J,K | 23000 | 30000 | 680 | 681 | | | |
| 1.1 | 1R1 | | | | 7.5 | 7R5 | | | 75 | 750 | | | | 750 | 751 | F,G, | 10001/ | 1500V |
| 1.2 | 1R2 | | | | 8.2 | 8R2 | | | 82 | 820 | | | | 820 | 821 | J,K | 10000 | 13000 |
| 1.3 | 1R3 | | | | 9.1 | 9R1 | | | 91 | 910 | | | | 910 | 911 | | | |
| 1.4 | 1R4 | | | | 10 | 100 | | | 100 | 101 | | | | 1000 | 102 | | | |
| 1.5 | 1R5 | | | | 11 | 110 | | | 110 | 111 | | | | 1100 | 112 | | | |
| 1.6 | 1R6 | B,C, | 25001/ | 3600V | 12 | 120 | | | 120 | 121 | | | | 1200 | 122 | | | |
| 1.7 | 1R7 | D | 23000 | 30007 | 13 | 130 | | | 130 | 131 | | | | 1500 | 152 | | | |
| 1.8 | 1R8 | | | | 15 | 150 | | | 150 | 151 | | | | 1800 | 182 | F,G, | 500V | N/A |
| 1.9 | 1R9 | | | | 16 | 160 | | | 160 | 161 | F,G, | 25001/ | 3000V | 2200 | 222 | J,K | 5000 | |
| 2.0 | 2R0 | | | | 18 | 180 | 5.0 | | 180 | 181 | J,K | 25001 | 30007 | 2700 | 272 | | | |
| 2.1 | 2R1 | | | | 20 | 200 | F,G, J,K | 2500V 3600 | V 200 | 201 | | | | | | | | |
| 2.2 | 2R2 | | | | 22 | 220 | -, | | 220 | 221 | | | | | | | | |
| 2.4 | 2R4 | | | | 24 | 240 | | | 240 | 241 | | | | | | | | |
| 2.7 | 2R7 | | | | 27 | 270 | | | 270 | 271 | | | | | | | | |
| 3.0 | 3R0 | | | | 30 | 300 | | | 300 | 301 | | | | | | | | |
| 3.3 | 3R3 | | | | 33 | 330 | | | 330 | 331 | F,G, | 15001/ | 2000V | | | | | |
| 3.6 | 3R6 | | | | 36 | 360 | | | 360 | 361 | J,K | 10000 | 20000 | | | | | |
| 3.9 | 3R9 | | | | 39 | 390 | | | 390 | 391 | | | | | | | | |





2225C/P (0.220" x 0.250")

+ Termination Types and Codes Chip Termination: Microstrip Termination: Codes: W, L, P Codes: MS, MN Axial Ribbon Termination: Radial Wire Termination: Code: AR, AN Codes: RW, RN Radial Ribbon Termination: Code: RR, FN Axial Wire Termination: Codes: AW, BN Termination Magnetic Termination **Non-Magnetic** \bigotimes \bigcirc Termination Code **Termination** Code 100% Sn 100%Sn RoHS Р W Solder over Copper Plating Solder over Nickel Plating 90% Sn10%Pb Tin/Lead MN L Solder over Nickel Plating AN MS RoHS FN Silver-Plated Copper AR ROHS RN Silver-Plated Copper RoHS RR BN

Note: "Non-Magnetic" means no magnetic materials.



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RW

AW ROHS

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2225C/P (0.220" x 0.250")

For Termination Types For Termination Types images, see previous page

Unit: inch (millimeter)

| | | | Magnetic | Termina | tions | | | | | |
|------|------------------|---|--|------------------------|-----------------------------------|------------------------|--|---|--|--|
| | | Cap | acitor Dim | | Le | ad Dimensio | ons | | | |
| | | Length | Width | Thicknes | s Overlap | Length | Width | Thickness | | |
| Code | Term. | Lc | Wc | Tc | В | $\mathbf{L}\mathbf{L}$ | WL | TL | | |
| W/L | Chip | 0.225 -0.010+0.25 (5.72 -0.25+ 0.64) | $\begin{array}{c} 0.250 \pm \\ 0.015 \\ (6.35 \pm 0.38) \end{array}$ | 0.165 (4.19) max | 0.020~0.047 (0.50~1.20) max | | | | | |
| MS | Microstrip | | | | | 0.500 | 0.240 ± 0.005 | 0.008 ± 0.001 | | |
| AR | Axial Ribbon | | | | | (12.70) min | | (0.2 ±0.025) | | |
| RR | Radial Ribbon | $\begin{array}{c} 0.245 \pm 0.025 \\ (6.22 \pm 0.64) \end{array}$ | $\begin{array}{c} 0.250 \pm 0.015 \\ (6.35 \pm 0.38) \end{array}$ | 0.150 (3.81) max | | 0.354 (9.00) min | $\begin{array}{c} 0.118 \pm 0.005 \\ (3.0 \pm 0.13) \end{array}$ | $\begin{array}{c} 0.012 \pm 0.001 \\ (0.3 \pm 0.025) \end{array}$ | | |
| RW | Radio Wire | | | | | 0.709 (18.00) min | _ |)31 ±0.004 | | |
| AW | Axial Wire | | | | | 0.906 (23.00) min | (0.80 | ±0.10) | | |
| | | (📎 N | Non-Magne | tic Term | inations 🧭 | 9 | | | | |
| | | Сар | acitor Dim | ensions | | Lead Dimensions | | | | |
| | | Length | Width | Thicknes | s Overlap | Length | Width | Thickness | | |
| Code | Term. | Lc | Wc | Tc | В | LL | WL | TL | | |
| Р | Chip | 0.225 -0.010+0.25 (5.72 -0.25+ 0.64) | $\begin{array}{c} 0.250 \pm \\ 0.015 \\ (6.35 \pm 0.38) \end{array}$ | 0.165 (4.19) max | 0.020~0.047 (0.50~1.20) max | | | | | |
| MN | Microstrip | | | | | 0.500 | 0.240 ± 0.005 | 0.008 ± 0.001 | | |
| AN | Axial Ribbon | | | 0.150 | | (12.70) min | (6.1 ± 0.13) | (0.2 ±0.025) | | |
| FN | Radial Ribbon | $\begin{array}{c} 0.245 \pm 0.025 \\ (6.22 \pm 0.64) \end{array}$ | $\begin{array}{c} 0.250 \pm 0.015 \\ (6.35 \pm 0.38) \end{array}$ | 0.150 (3.81) max | | 0.354 (9.00) min | 0.118 ±0.005 (3.0 ±0.13) | $\begin{array}{c} 0.012 \pm 0.001 \\ (0.3 \pm 0.025) \end{array}$ | | |
| RN | Radial Wire | | | | | 0.709 (18.00) min | - | 031 ±0.004 | | |
| BN | Axial Wire | | | | | 0.906 (23.00) min | (0.80 | ±0.10) | | |

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.





2225C/P (0.220" x 0.250")

÷ Electrical Specifications

| Quality Factor (Q) | Greater than 10,000 at 1 MHz |
|--|--|
| Insulation Resistance (IR) | Test Voltage: 500V 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC |
| Rated Voltage | See Rated Voltage Table |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds, Rated Voltage \leq 500VDC 150% of Voltage for 5 seconds, 500VDC <rated <math="" voltage="">\leq 1250 VDC 120% of Voltage for 5 seconds, Rated Voltage > 1250 VDC</rated> |
| Operating Temperature Range | -55°C to 200°C |
| Temperature Coefficient (TC) | C: -55°C to 125°C 0±30ppm/°C; >125°C to 200°C 0±60ppm/°C P: -55°C to 200°C +90±20ppm/°C |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater |
| Piezoelectric Effects | None |
| Termination Type | See Termination Type Table |
| | |

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

† Environmental Specifications

| | Specification | Test Parameters | | | |
|----------------------------|--|---|--|--|--|
| Thermal Shock Moisture | DWV: The initial Value IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 0.5% or 0.5pF, | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. | | | |
| Resistance | whichever is greater. | MIL-STD-202, Method 106 | | | |
| Humidity (Steady State) | DWV: The initial Value IR: The initial value. Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater. | MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. | | | |
| Life | IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater. | MIL-STD-202, Method 108. For 2000 hours, at 200°C. 200% of Voltage for Capacitors, Rated Voltage \leq 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage \leq 1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC | | | |
| Terminal Strength | Force: 20lbs typical, 10lbs. Minimum. Duration Time: 5 to 10 seconds | MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations. | | | |

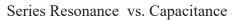


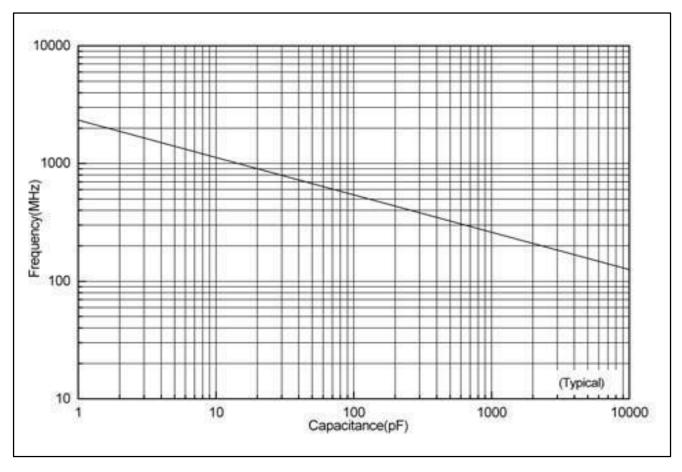
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2225C/P (0.220" x 0.250")

≠ Series Resonance vs. Capacitance





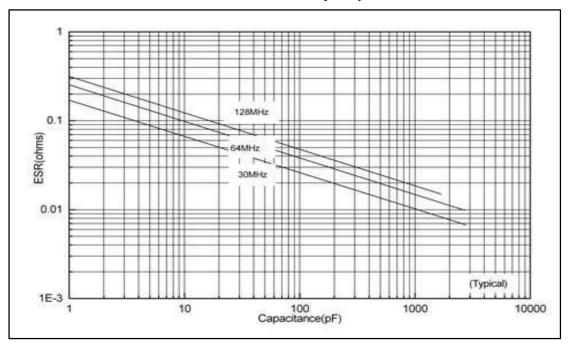




2225C/P(0.220" x 0.250")

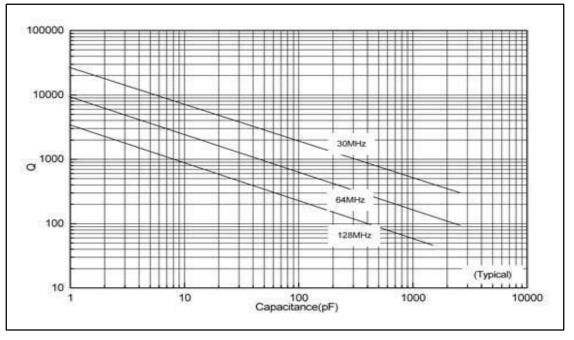
≑ ESR vs. Frequency

2225C/P ESR vs Frequency



茾 Q vs. Capacitance

Q vs Capacitance



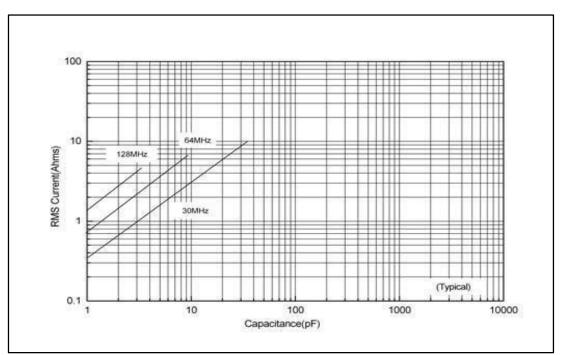


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2225C/P (0.220" x 0.250")

Current Rating vs. Capacitance



2225C/P Current Rating vs Capacitance

The current depends on voltage limited:

$$I = \frac{\sqrt{2}}{2} I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_c} = \sqrt{2} \pi F C V_{rated}$$

The current depends on power dissipation limited:

$$I = \sqrt{\frac{P_{dissipation}}{ESR}}$$

Note: If the thermal resistance of mounting surface is 15° C/W, then a power dissipation of 4W will result in the current limited.

We can calculate the current limited.

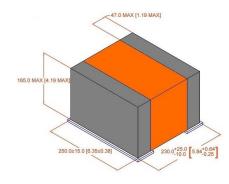




2225C/P (0.220" x 0.250")

Capacitor Application Program

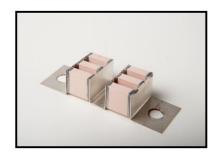
Passive Plus, Inc.'s brand new **online Capacitor Application Program** (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



÷ Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.





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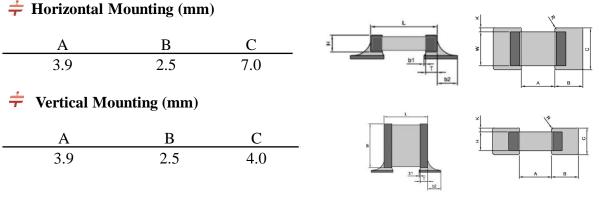
2225C/P (0.220" x 0.250")

Field Freedom Recommended Land Pattern Dimensions

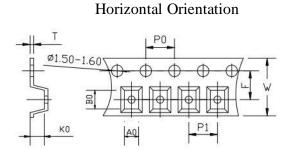
When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.



Tape & Reel Specifications (mm)



| Orientation | W | P0 | P1 | Т | F | Qty Min | Qty/reel | Tape Material |
|-------------|-------|-----------|-------|------|------|---------|----------|------------------|
| Horizontal | 16.00 | 4.00 | 12.00 | 0.30 | 7.50 | 500 | 500 | Plastic |

$A_0 B_0 K_0$

Determined by component size. Typical clearance between the cavity and the component is:

.05 (.002) min to .50 (.020) max for 8mm tape and .50 (.002) min to .65 (.026) max for 12mm tape.

- The component cannot rotate more than 20° within the determined cavity.





3838C/P (0.380" x 0.380")

Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 0.5pF to 5100pF
- Working Voltage: 3600V
- Extended Voltage: 7200V

F Product Applications

Typical Functional Applications:

- Tuning Bypass Coupling
- D.C. Blocking Impedance Matching

Typical Circuit Applications

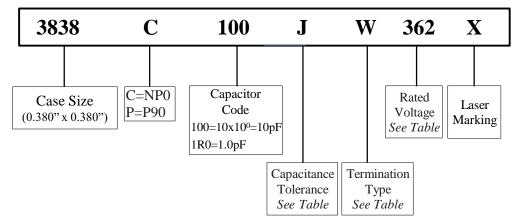
- HF/ RF Power Amplifiers Antenna
- Tuning Plasma Chambers Medical

Equipment • Transmitters



Marking shown for illustration purposes only. Actual marking may differ.

茾 Part Numbering



Capacitance Tolerance Codes

| Со | de | Α | В | С | D | F | G | J | K |
|----|-------|---------|--------|---------|--------|-----|-----|-----|------|
| Тс | ol. : | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |

Foltage Codes

| Voltage | Code |
|---------|------|
| 500V | 501 |
| 1000V | 102 |
| 2500V | 252 |
| 3600V | 362 |
| 7200V | 722 |
| | |



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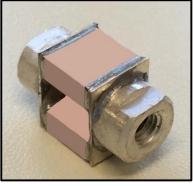
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3838C/P(0.380" x 0.380")

† 3838C/P Capacitance Values

Special capacitances, tolerances and WVDC are available. Please contact PPI.



| 0.5 0.7 4.7 4.7 4.7 4.7 51 510 560 620 680 620 68 | 561 631 E.G | WVDC 2500V |
|---|---|----------------------|
| 0.6 0R6 0R7 5.1 5R1 5R1 5R6 560 560 620 680 680 680 680 680 680 680 750 750 750 750 750 750 820 820 820 910 910 910 910 910 910 910 1000 <th>621 F,G, 21 681 J,K 751 2 821 911 .</th> <th>2500V</th> | 621 F,G, 21 681 J,K 751 2 821 911 . | 2500V |
| 0.7 0R7 | 681 J,K 2 751 2 821 911 4 | 2500V |
| 0.8 0R8 6.2 6R2 B,C, 3600V 7200V 68 680 F 750 750 750 750 750 750 750 820 820 820 820 820 910 <td< th=""><th>681 J,K 751 821 911 911</th><th></th></td<> | 681 J,K 751 821 911 911 | |
| 0.9 0R9 6.8 6R8 D 3600V 7200V 75 750 820 820 820 820 820 820 820 910 | 821 911 | |
| 0.9 0R9 6.8 6R8 D 75 750 820 820 820 820 820 820 820 820 820 820 910< | 911 | |
| 1.1 1R1 8.2 8R2 91 910 F,G, 3600V 7200V 1000 1 | | |
| | 102 | |
| | | |
| | 112 | |
| 1.3 1R3 10 100 110 111 1200 1 | 122 F,G, 1 | 1000V |
| 1.4 1R4 11 110 120 121 1500 1 | 152 | |
| 1.5 1R5 12 120 130 131 1800 1 | 182 | |
| 1.6 1R6 13 130 150 151 2200 2 | 222 | |
| 1.7 1R7 D 3600V 7200V 15 150 160 161 2400 2 | 242 | |
| | 272 | |
| | 302 | |
| | 332 | |
| F,G, 3500V 7200V 240 244 | 362 E.G | |
| 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 | 392 J,K | 500V |
| 3000V N/A | 432 | |
| | 472 | |
| | 512 | |
| 3.3 3R3 36 360 390 391 | | |
| 3.6 3R6 39 390 430 431 | | |
| F,G, 2500V N/A | | |
| 3.9 3R9 43 430 470 471 J,K 2500V N/A 4.3 4R3 47 470 510 511 1 | | |



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3838C/P (0.380" x 0.380")

\neq Termination Types and Codes

| Le Vie | Chip Termination: Codes: W, L, P | | Microstrip Termination: Codes: MS, MN |
|--|--|--|---|
| | Axial Ribbon Termination: Code: AR, AN | We transformed to the second s | Radial Wire Termination: Codes: RW, RN |
| | Radial Ribbon Termination: | | Axial Wire Termination: Codes: AW, BN |
| | Code: RR, FN | | |
| Termination Code | Code: RR , FN Magnetic Termination | Termination Code | Non-Magnetic Terminations |
| | | Code P Koms | |
| Code | Magnetic Termination 100% Sn | Code P Koms MN Koms | Terminations 100%Sn |
| Code W Koms | Magnetic Termination 100% Sn Solder over Nickel Plating 90% Sn10% Pb Tin/Lead | Code P Koms MN Koms AN Koms | Terminations 100% Sn Solder over Copper Plating |
| Code W Kohs L | Magnetic Termination 100% Sn Solder over Nickel Plating 90% Sn10% Pb Tin/Lead | Code P Koms MN Koms AN Koms FN Koms | Terminations 100%Sn |
| Code W Korrs L MS Korrs | Magnetic Termination 100% Sn Solder over Nickel Plating 90% Sn10% Pb Tin/Lead | Code P Koms MN Koms AN Koms | Terminations 100% Sn Solder over Copper Plating |
| Code W Korrs L MS Korrs AR Korrs | Magnetic Termination 100% Sn Solder over Nickel Plating 90% Sn10% Pb Tin/Lead Solder over Nickel Plating | Code P Koms MN Koms AN Koms FN Koms | Terminations 100% Sn Solder over Copper Plating |



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3838C/P(0.380" x 0.380")

† Termination Types For Termination Types images, see previous page

Unit: inch (millimeter)

| | | | Μ | agnetic Te | rminations | | | |
|------|------------------|--|--------------------------------|------------------------|----------------------------|----------------------|---|---|
| | | | Capacitor Di | mensions | | | Lead Dimensio | ns |
| | | Length | Width | Thickness | Overlap | Length | Width | Thickness |
| Code | Term. | Lc | Wc | Tc | В | LL | WL | TL |
| W | Chip | 0.380 -0.010+0.015 (9.65 - 0.25+0.38) | 0.380 ±0.010 (9.65±0.25) | 0.170 (4.32) max | 0.024~0.059 | | | |
| MS | Microstrip | | | | | 0.728 | 0.350 ± 0.020 (8.89 ± 0.50) | 0.008±0.001 |
| AR | Axial Ribbon | 0.380 | 0.380 | | | (18.50) min | 0.315±0.010 (8.00±0.25) | (0.20±0.025) |
| RR | Radial Ribbon | -0.010.+0.015 (9.65 | ± 0.010 (9.65 | 0.177 (4.50) | | 0.354 (9.00) min | 0.118 ± 0.010 (3.0 ± 0.25) | $\begin{array}{c} 0.012 \pm 0.001 \\ (0.3 \pm 0.025) \end{array}$ |
| RW | Radial Wire | -0.25+0.38) | (9.03 ±0.25) | max | | 0.709 (18.00) min | Dia.: 0.031±0 | 0.004 |
| AW | Axial Wire | | | | | 0.906 (23.00) min | (0.80± | 0.10) |
| | | | 🐼 Non | -Magnetic | Terminatio | on: 🐼 | | |
| - | | | Capa | citor Dimens | sions | | Lead Dimensio | ns |
| | | Length | Width | Thickness | Overlap | Length | Width | Thickness |
| Code | Term. | Lc | Wc | Тс | В | LL | WL | TL |
| P | Chip | 0.380 -0.010+0.015 (9.65 - 0.25+0.38) | 0.380 ±0.010 (9.65±0.25) | 0.170 (4.32) max | 0.024~0.059 (0.60~1.50) | | | |
| MN | Microstrip | | | | | 0.728 | $\begin{array}{c} 0.350 \pm 0.020 \\ (8.89 \pm 0.50) \end{array}$ | 0.008 ± 0.001 |
| AN | Axial Ribbon | 0.380 -0.010+0.015 | 0.380 ± 0.010 | 0.177 | | (18.50) min | 0.315±0.010 (8.00±0.25) | (0.20 ± 0.025) |
| FN | Radial Ribbon | -0.010+0.015 | ±0.010 (9.65 | (4.50) max | | 0.354 (9.00) min | $\begin{array}{c} 0.118 \pm 0.010 \\ (3.0 \pm 0.25) \end{array}$ | $\begin{array}{c} 0.012 \pm 0.001 \\ (0.3 \pm 0.025) \end{array}$ |
| RN | Radial Wire | -0.25+0.38) | ±0.25) | mux | | 0.709 (18.00) min | | |
| BN | Axial Wire | | | | | 0.906 (23.00) min | (0.80 ± 0.00) | .10) |

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.



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3838C/P (0.380" x 0.380")

Electrical Specifications

| Quality Factor (Q) | Greater than 10,000 at 1 MHz | | | |
|--|--|--|--|--|
| Insulation Resistance (IR) | Test Voltage: 500V 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC | | | |
| Rated Voltage | See Rated Voltage Table | | | |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds, Rated Voltage \leq 500VDC 150% of Voltage for 5 seconds, 500VDC <rated <math="" voltage="">\leq 1250 VDC 120% of Voltage for 5 seconds, Rated Voltage > 1250 VDC</rated> | | | |
| Operating Temperature Range | -55°C to 200°C | | | |
| Temperature Coefficient (TC) | C: -55°C to 125°C 0±30ppm/°C; >125°C to 200°C 0±60ppm/°C P: -55°C to 200°C +90±20ppm/°C | | | |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater | | | |
| Piezoelectric Effects | None | | | |
| Termination Type | See Termination Type Table | | | |

Environmental Specifications

| | Specification | Test Parameters |
|----------------------------|---|--|
| Thermal Shock | DWV: The initial value IR: Shall not be less than 30% of the initial value. Capacitance Change: | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Moisture Resistance | No more than 0.5% or 0.5pF, whichever is greater. | MIL-STD-202, Method 106 |
| Humidity (Steady State) | DWV: The initial value IR: The initial value Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater. | MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater. | MIL-STD-202, Method 108. For 2000 hours, at 200°C. 200% of Voltage for Capacitors, Rated Voltage \leq 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage \leq 1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC |
| Terminal Strength | Force: 20lbs typical, 10lbs. min. Duration Time: 5 to 10 seconds | Applied a force and maintained for a period of 5 to 10 seconds |

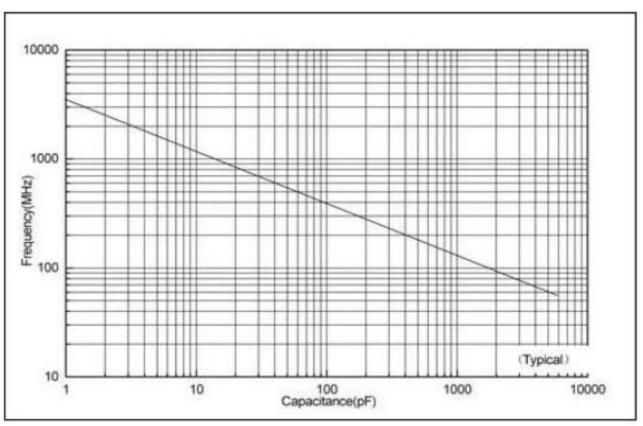
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.





3838C/P(0.380" x 0.380")

≠ Series Resonance vs. Capacitance



Series Resonance vs. Capacitance



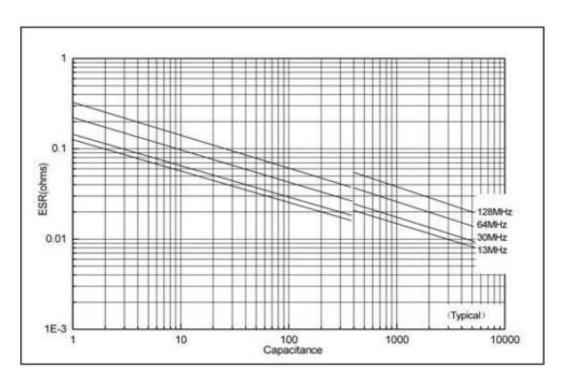
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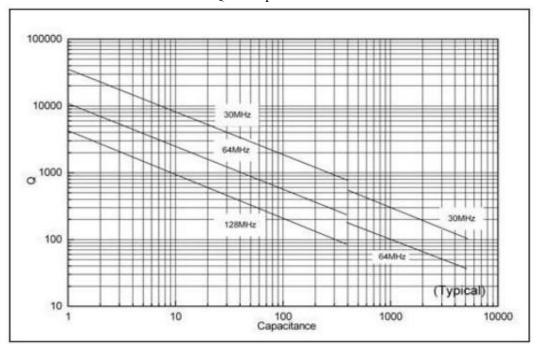
3838C/P (0.380" x 0.380")

ESR vs. Frequency

ESR vs Frequency



Q vs Capacitance





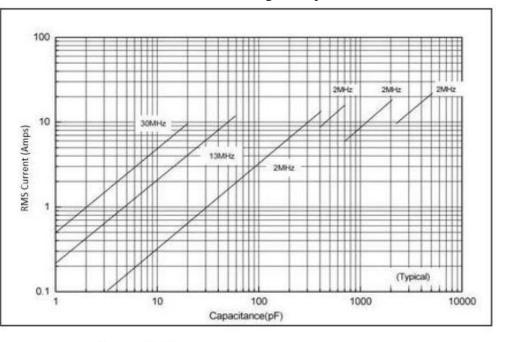
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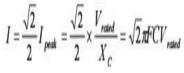
3838C/P (0.380" x 0.380")

茾 Current Rating vs. Capacitance



3838C/P Current Rating vs Capacitance

The current depends on voltage limited:



The current depends on power dissipation limited:

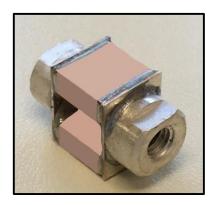
 $I = \sqrt{\frac{P_{abssipation}}{ESR}}$

Note: If the thermal resistance of mounting surface is 12°C/W, then a power dissipation of 5W will result in the current limited. We can calculate the current limited.

÷ Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.





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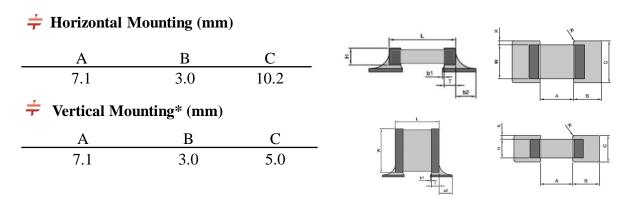
3838C/P (0.380" x 0.380")

Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

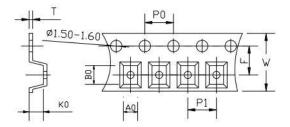
1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.



÷ Tape & Reel Specifications (mm)

Horizontal Orientation



| Orientation | W | PO | P1 | Т | F | Qty Min | Qty/ reel | Tape Material |
|-------------|-------|------|-------|------|------|------------|--------------|------------------|
| Horizontal | 16.00 | 4.00 | 12.00 | 0.30 | 7.50 | 50 | 200 | Plastic |

$A_0 B_0 K_0$

Determined by component size. Typical clearance between the cavity and the component is:
 .05 (.002) min to .50 (.020) max for 8mm tape and .50 (.002) min to .65 (.026) max for 12mm tape.

• The component cannot rotate more than 20° within the determined cavity.



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Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 1.0pF to 6800pF
- Working Voltage: 5000V
- Extended Voltage: 8000V

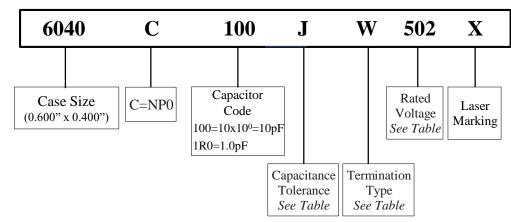
+ Typical Circuit Applications

- Semiconductor Manufacturing
- High Energy Power Transfers
- Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only. Actual marking may differ.

茾 Part Numbering



Capacitance Tolerance Codes

| Code | В | С | D | F | G | J | K |
|------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |

Voltage Codes

| Voltage | Code |
|---------|------|
| 1000V | 102 |
| 2000V | 202 |
| 3000V | 302 |
| 5000V | 502 |
| 8000V | 802 |
| 00001 | 002 |



+1 (631) 425-0938



6040C (0.600" x 0.400")

6040C Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.



Marking shown for illustration purposes only. Actual marking may differ.

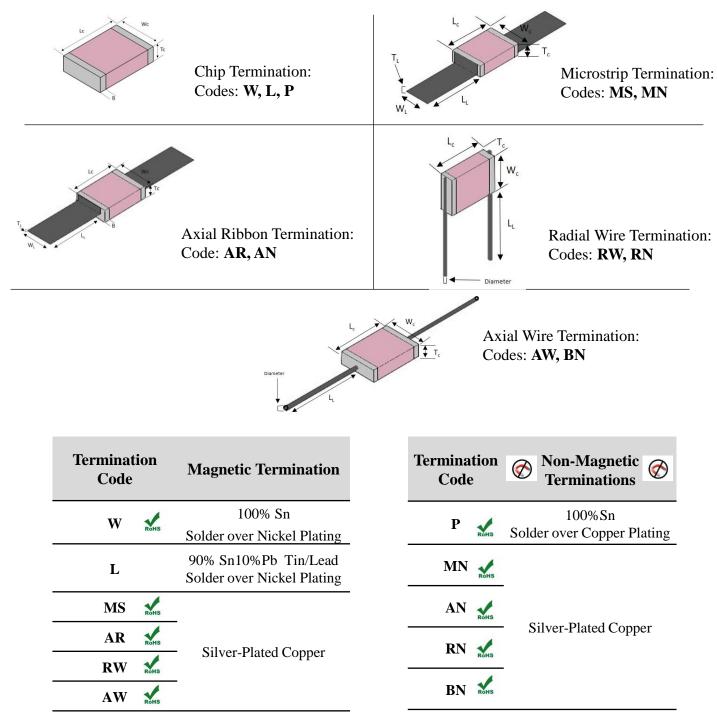
| Cap. | Сар | Tol. | Rated WVDC | Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | <u>Rated</u> | WVDC |
|------|------|-------------|-------------|------|------|-------------|--------|--------|------|------|-------------|--------------|--------|
| рF | Code | 101. | Std. Ext. | рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. |
| 1.0 | 1R0 | | | 39 | 390 | | | | 1500 | 152 | БС | | |
| 1.2 | 1R2 | | | 47 | 470 | | | | 1800 | 182 | F,G, J,K | 2000V | 3000V |
| 1.5 | 1R5 | | | 56 | 560 | F,G, | 50001/ | 8000V | 2200 | 222 | - / | | |
| 1.8 | 1R8 | | | 68 | 680 | J,K | 50000 | 8000 V | 2700 | 272 | | | |
| 2.2 | 2R2 | | | 82 | 820 | | | | 3300 | 332 | | | |
| 2.7 | 2R7 | B,C, | 5000V 8000V | 100 | 101 | | | | 4700 | 472 | F,G, | 1000V | 2000\/ |
| 3.3 | 3R3 | D | 50000 00000 | 120 | 121 | | | | 5100 | 512 | J,K | 10000 | 2000 V |
| 3.9 | 3R9 | | | 150 | 151 | | | | 5600 | 562 | | | |
| 4.7 | 4R7 | | | 180 | 181 | | | | 6800 | 682 | | | |
| 5.6 | 5R6 | | | 220 | 221 | | | | | | | | |
| 6.8 | 6R8 | | | 270 | 271 | F,G, | 3000V | 5000V | | | | | |
| 8.2 | 8R2 | | | 330 | 331 | J,K | 30000 | 50000 | | | | | |
| 10 | 100 | | | 390 | 391 | | | | | | | | |
| 12 | 120 | | | 470 | 471 | | | | | | | | |
| 15 | 150 | 5.0 | | 560 | 561 | | | | | | | | |
| 18 | 180 | F,G, J,K | 5000V 8000V | 680 | 681 | | | | | | | | |
| 22 | 220 | •, | | 820 | 821 | | | | | | | | |
| 27 | 270 | | | 1000 | 102 | F,G, J,K | 2000V | 3000V | | | | | |
| 33 | 330 | | | 1200 | 122 | •, | | | | | | | |





6040C (0.600" x 0.400")

† Termination Types and Codes



Note: "Non-Magnetic" means no magnetic materials.



+1 (631) 425-0938



6040C (0.600" x 0.400")

† Terminations

For Termination Types images, see previous page

Unit: inch (millimeter)

| | | | Μ | agnetic Termi | nations | | | |
|------|-----------------|--|----------------------------|-----------------------------------|------------------------|----------------------|-------------------|--------------------|
| | | | Capacitor Di | mensions | |] | Lead Dimension | S |
| | | Length | Width | Thickness | Overlap | Length | Width | Thickness |
| Code | Term. | Lc | Wc | Tc | В | LL | WL | TL |
| W | Chip | 0.614 -0.010+0.015 (15.6 -0.25+0.38) | 0.433±0.010 (11.0±0.25) | 0.154±0.008 (3.90±0.20) max | 0.063 (1.60) max | - | - | - |
| MS | Microstrip | | | | | 0.787 | 0.350 ± 0.010 | 0.008±0.001 |
| AR | Axial Ribbon | 0.614 -0.010+0.015 | 0.433±0.010 | 0.154 ± 0.008 | | (20.0) min | (8.89±0.25) | (0.20 ± 0.025) |
| RW | Radial Wire | (15.6 -0.25+0.38) | (11.0±0.25) | (3.90±0.20) max | - | 0.787 (20.00) min | _ Dia.: 0.030±0 | |
| AW | Axial Wire | | | | | 0.984 (25.00) min | (0.80 ± 0.00) |).10) |
| | | | 🐼 Non | -Magnetic Ter | minations | \bigotimes | | |
| | | | Capacitor Di | mensions | |] | Lead Dimension | s |
| | | Length | Width | Thickness | Overlap | Length | Width | Thickness |
| Code | Term. | Lc | Wc | Tc | В | LL | WL | TL |
| Р | Chip | 0.614 -0.010+0.015 (15.6 -0.25+0.38) | 0.433±0.010 (11.0±0.25) | 0.154±0.008 (3.90±0.20) max | 0.063 (1.60) max | - | - | - |
| MN | Microstrip | | | | | 0.787 | 0.350 ± 0.010 | 0.008 ± 0.001 |
| AN | Axial Ribbon | 0.614 -0.010+0.015 | 0.433±0.010 | 0.154±0.008 | | (20.0) min | (8.89±0.25) | (0.20 ± 0.025) |
| RN | Radial Wire | | (11.0±0.25) | (3.90±0.20) max | - | 0.787 (20.00) min | - Dia.: 0.031 ±0 | .004 |
| BN | Axial Wire | | | | | 0.984 (25.00) min | (0.80 ± 0.1) | |

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.



+1 (631) 425-0938



6040C (0.600" x 0.400")

Electrical Specifications

| Quality Factor (Q) | No less than 1000pF, Q value more than 2000, Test Frequency 1MHz; More than 1000pF, Q value more than 2000, Test Frequency 1MHz | | | |
|--|--|--|--|--|
| Insulation Resistance (IR) | Test Voltage: 500V 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC | | | |
| Rated Voltage | See Rated Voltage Table | | | |
| Dielectric Withstanding Voltage (WVDC) | 250% of Voltage of 5 seconds, Rated Voltage \leq 500VDC 150% of Voltage for 5 seconds, 500VDC <rated <math="" voltage="">\leq 1250 VDC 120% of Voltage for 5 seconds, Rated Voltage > 1250 VDC</rated> | | | |
| Operating Temperature Range | -55°C to 175°C | | | |
| Temperature Coefficient (TC) | -55°C to 125°C 0±30ppm/°C >125°C to 175°C 0±60ppm/°C | | | |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater | | | |
| Piezoelectric Effects | None | | | |
| Termination Type | See Termination Type Table | | | |

Environmental Specifications

| | Specification | Test Parameters |
|----------------------------|---|--|
| Thermal Shock | DWV: The initial value IR: Shall not be less than 30% of the initial value. Capacitance Change: | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Moisture Resistance | No more than 0.5% or 0.5pF, whichever is greater. | MIL-STD-202, Method 106 |
| Humidity (Steady State) | DWV: The initial value IR: The initial value Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater. | MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater. | MIL-STD-202, Method 108. For 2000 hours, at 125°C. 200% of Voltage for Capacitors, Rated Voltage \leq 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage \leq 1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC |
| Terminal Strength | Force: 25lbs typical, 20lbs. min. Duration Time: 5 to 10 seconds | |

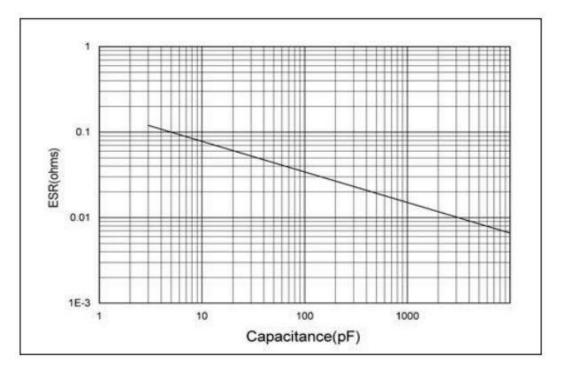
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.



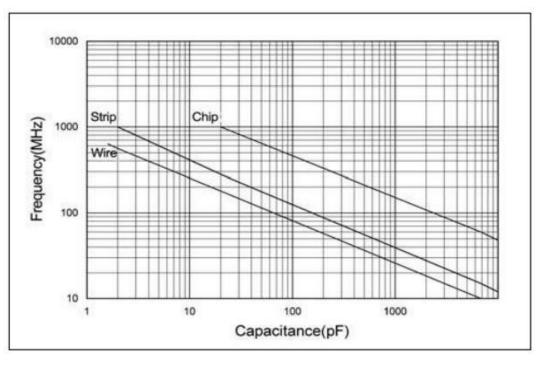


6040C (0.600" x 0.400")

≠ ESR vs. Capacitance Measured @ 30MHz



Self Resonant Frequency vs. Capacitance

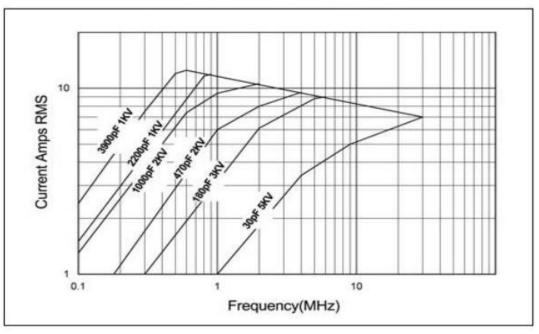




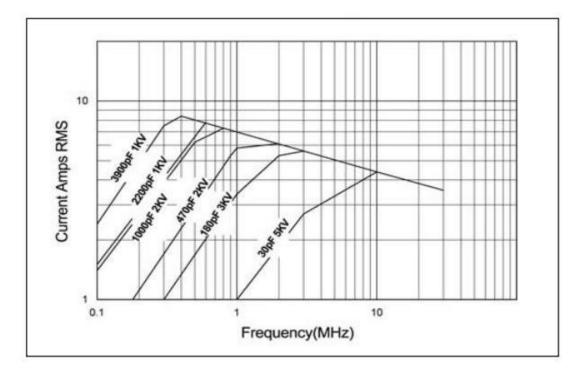
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÷ Strip Terminals Rated Current vs. Frequency



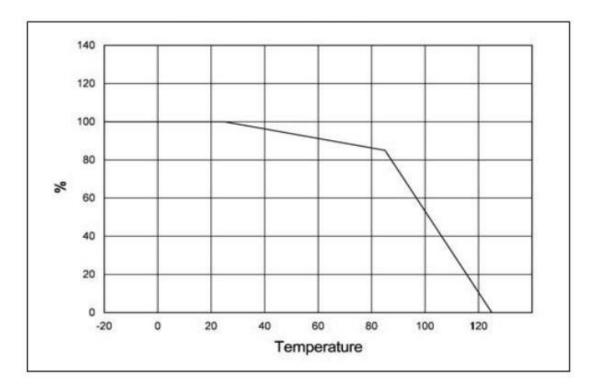
i Wire Terminals Rated Current vs. Frequency







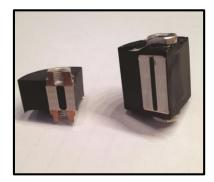
≠ % Maximum Current vs. Ambient Temperature



t Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.





+1 (631) 425-0938

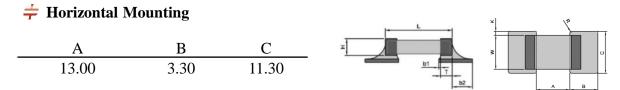


Free Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.



Dimensions: mm





7676C (0.760" x 0.760")

Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 1.0pF to 20000pF
- Working Voltage: 5000V
- Extended Voltage: 8000V

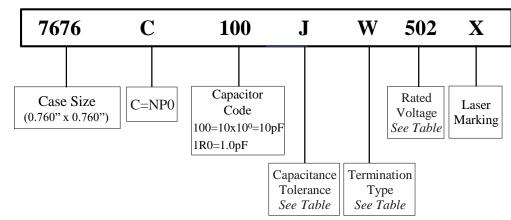
+ Typical Circuit Applications

- Semiconductor Manufacturing
- High Energy Power Transfers
- Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only. Actual marking may differ.

Part Numbering



† Capacitance Tolerance Codes

| Code | В | С | D | F | G | J | K |
|------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |

Voltage Codes

| Voltage | Code |
|---------|------|
| 1000V | 102 |
| 2000V | 202 |
| 3000V | 302 |
| 5000V | 502 |
| 8000V | 802 |



+1 (631) 425-0938



7676C (0.760" x 0.760")

÷ 7676C Capacitance Values

Special capacitances, tolerances and WVDC are available. Please contact PPI.



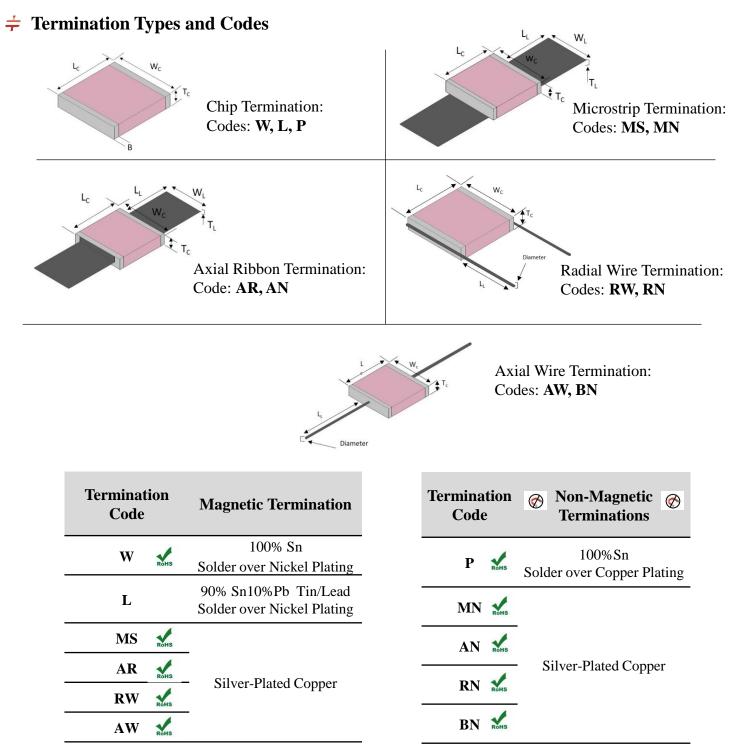
Marking shown for illustration purposes only. Actual marking may differ.

| Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | Rated | WVDC | | | | | | | | | | | | | |
|------|------|------|---|--------|------|------|-------------|--------------|-------|-------|------|-----------|--------------|-------|-------|-------|--|-----|-----|--|--|--|------|-----|--|--|--|
| рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. | | | | | | | | | | | | | |
| 1.0 | 1R0 | | | | 33 | 330 | | | | 1000 | 102 | | | | | | | | | | | | | | | | |
| 1.2 | 1R2 | | | 39 | 390 | | | | 1200 | 122 | | | | | | | | | | | | | | | | | |
| 1.5 | 1R5 | | | | 47 | 470 | | | : | 1500 | 152 | | | | | | | | | | | | | | | | |
| 1.8 | 1R8 | | | | 56 | 560 | | | | 1800 | 182 | | | | | | | | | | | | | | | | |
| 2.2 | 2R2 | | | | 68 | 680 | ГС | | | 2200 | 222 | G,J, K | 3000V | 5000V | | | | | | | | | | | | | |
| 2.7 | 2R7 | B,C, | 5000V | 8000V | 82 | 820 | F,G, J,K | 5000V | 8000V | 2700 | 272 | | | | | | | | | | | | | | | | |
| 3.3 | 3R3 | D | 5000 0 | 00000 | 100 | 101 | - / | | | 3300 | 332 | | | | | | | | | | | | | | | | |
| 3.9 | 3R9 | | | | 120 | 121 | | | | 4700 | 472 | | | | | | | | | | | | | | | | |
| 4.7 | 4R7 | | | | 150 | 151 | | | | 5100 | 512 | | | | | | | | | | | | | | | | |
| 5.6 | 5R6 | | 180 181 220 221 | | | | | | | | | | | | | | | 180 | 181 | | | | 5600 | 562 | | | |
| 6.8 | 6R8 | | | | 6800 | 682 | | | | | | | | | | | | | | | | | | | | | |
| 8.2 | 8R2 | | | | 270 | 271 | | | | 7500 | 752 | G,J, K | 1000V | 3000V | | | | | | | | | | | | | |
| 10 | 100 | | | | 300 | 301 | | | | 8200 | 822 | | | | | | | | | | | | | | | | |
| 12 | 120 | | | | 390 | 391 | 5.0 | | | 10000 | 103 | | | | | | | | | | | | | | | | |
| 15 | 150 | F,G, | 5000V | 8000V | 470 | 471 | F,G, J,K | 3000V | 5000V | 12000 | 123 | | | | | | | | | | | | | | | | |
| 18 | 180 | J,K | 30000 | 3000 V | 560 | 561 | •, | | | 15000 | 153 | G,J, | 10001 | 2000V | | | | | | | | | | | | | |
| 22 | 220 | | | | | | 680 | 681 | | | | 18000 | 183 | К | 10000 | 20000 | | | | | | | | | | | |
| 27 | 270 | | | | 820 | 821 | | | | 20000 | 203 | | | | | | | | | | | | | | | | |





7676C (0.760" x 0.760")



Note: "Non-Magnetic" means no magnetic materials.





7676C (0.760" x 0.760")

† **Termination Types** For Termination Types images, see previous page

| | | | | | | | Unit: | inch (millimeter) | | |
|------|--------------------------------------|--|----------------------------|-----------------------------------|--|--|--------------------|--------------------|--|--|
| | | | Μ | agnetic Termi | nations | | | | | |
| | Capacitor Dimensions Lead Dimensions | | | | | | | | | |
| | Length Width Thickness Overlap | | | | | | Width | Thickness | | |
| Code | Term. | Le | Wc | Тс | В | LL | WL | TL | | |
| W | Chip | | | | | - | - | - | | |
| MS | Microstrip | | | | 0.063 (1.60) max | 0.787 | 0.591 ± 0.010 | 0.008±0.001 | | |
| AR | Axial Ribbon | 0.760 -0.010+0.015 (19.3 -0.25+0.38) | 0.760±0.010 (19.3±0.25) | 0.154±0.008 (3.90±0.20) | | (20.0) min | (15.0±0.25) | (0.20± 0.025) | | |
| RW | Radial Wire | ` | | max | 0.787 (20.00) min Dia.: 0.030±0.004 | | | | | |
| AW | Axial Wire | | | | | 1.181 (0.80 ± 0.10) (30.00) min | | | | |
| | | | 🔗 Non | -Magnetic Ter | minations | \bigotimes | | | | |
| | | | Capacitor Di | nensions | | | Lead Dimension | S | | |
| | | Length | Width | Thickness | Overlap | Length | Width | Thickness | | |
| Code | Term. | Le | Wc | Тс | В | LL | WL | TL | | |
| Р | Chip | | | | | - | - | - | | |
| MN | Microstrip | | | | | 0.787 | 0.591 ± 0.010 | 0.008 ±0.001 | | |
| AN | Axial Ribbon | 0.760 -0.010+0.015 (19.3 -0.25+0.38) | 0.760±0.010 (19.3±0.25) | 0.154±0.008 (3.90±0.20) max | 0.063 (1.60) max | (20.0) min | (15.0 ± 0.25) | (0.20 ± 0.025) | | |
| RN | Radial Wire | | | шал | шал | 0.787 (20.00) min | – Dia.: 0.031 ±0 . | 004 | | |
| BN | Axial Wire | | | | | | (0.80 ± 0.000) | | | |

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.





7676C (0.760" x 0.760")

÷ Electrical Specifications

| Quality Factor (Q) | No less than 1000pF, Q value more than 2000, Test Frequency 1MHz; More than 1000pF, Q value more than 2000, Test Frequency 1MHz |
|--|---|
| Insulation Resistance (IR) | Test Voltage: 500V 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC |
| Rated Voltage | See Rated Voltage Table |
| Dielectric Withstanding Voltage (WVDC) | 250% of Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 1250="" vdc<br="" voltage="" ≤="">120% of Voltage for 5 seconds, Rated Voltage > 1250 VDC</rated> |
| Operating Temperature Range | -55°C to 175°C |
| Temperature Coefficient (TC) | -55°C to 125°C 0±30ppm/°C >125°C to 175°C 0±60ppm/°C |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater |
| Piezoelectric Effects | None |
| Termination Type | See Termination Type Table |

Environmental Specifications

| | Specification | Test Parameters |
|----------------------------|---|---|
| Thermal Shock | DWV: The initial value IR: Shall not be less than 30% of the initial value. Capacitance Change: | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Moisture Resistance | No more than 0.5% or 0.5pF, whichever is greater. | MIL-STD-202, Method 106 |
| Humidity (Steady State) | DWV: The initial value IR: The initial value Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater. | MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater. | MIL-STD-202, Method 108. For 2000 hours, at 125°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC |
| Terminal Strength | Force: 3 0lbs. min. Duration Time: 5 to 10 seconds | MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations. |

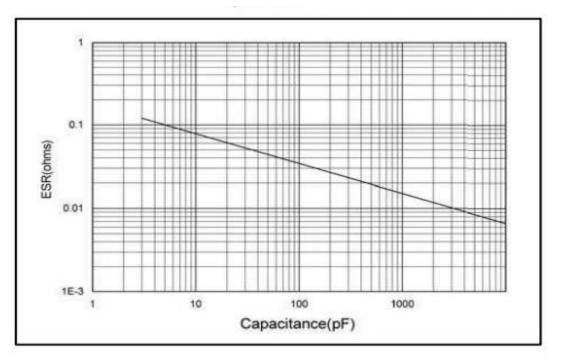
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.



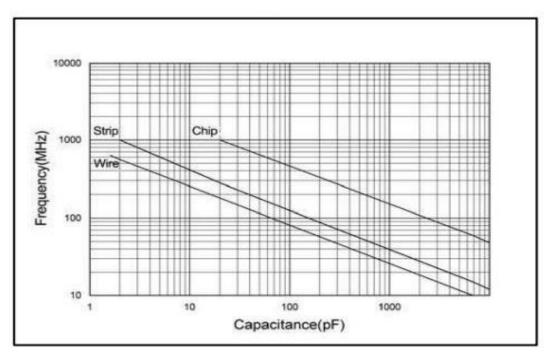


7676C (0.760" x 0.760")

÷ ESR vs. Capacitance Measured @ 30MHz



Self Resonant Frequency vs. Capacitance



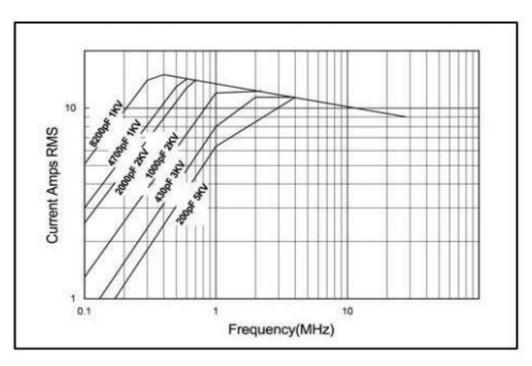


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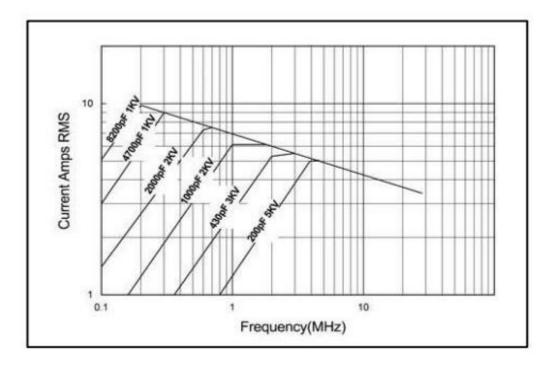


7676C (0.760" x 0.760")

÷ Strip Terminals Rated Current vs. Frequency



+ Wire Terminals Rated Current vs. Frequency

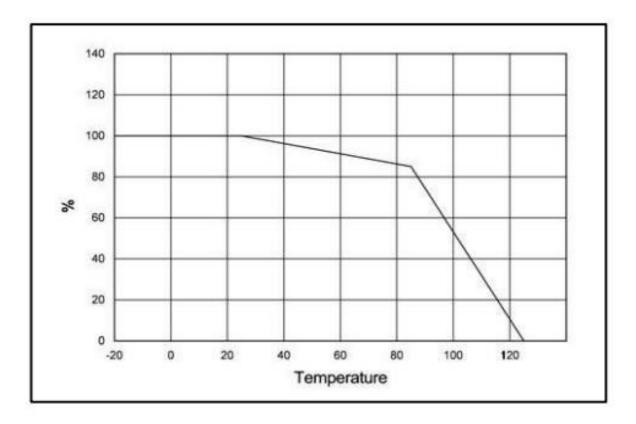






7676C (0.760" x 0.760")

% Maximum Current vs. Ambient Temperature



t Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.





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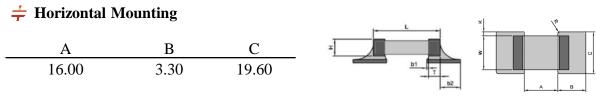
7676C (0.760" x 0.760")

Free Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.

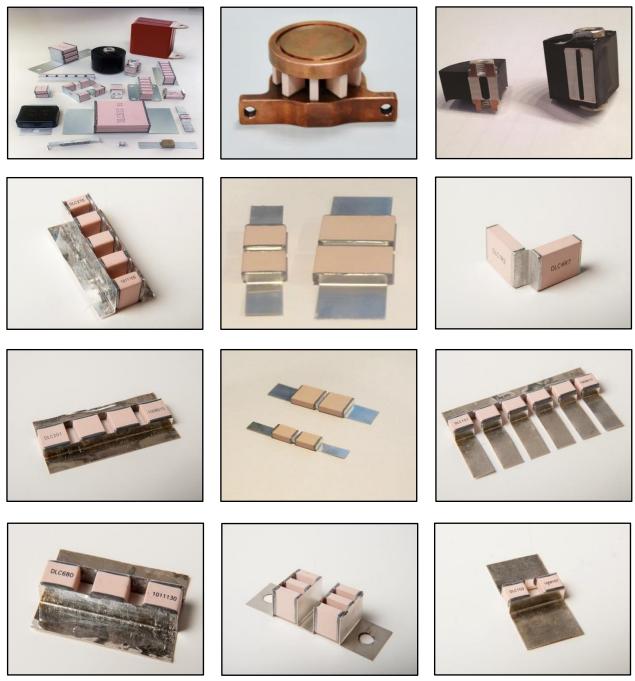


Dimensions: mm

www.passiveplus.com







Marking shown for illustration purposes only. Actual marking may differ.

Please contact PPI (sales@passiveplus.com) to discuss custom assembly options.



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www.passiveplus.com

PPICUSTOMASSEMBLIES042122RevA

sales@passiveplus.com



UHF/RF High Q Power Transmitter Capacitors (NP0 TC) Multi-Layer Ceramic Capacitors Custom Capacitor Assemblies

Product Features

High Operating Voltage, High Operating Current, Extended Capacitance, Tighter Tolerances, High Reliability, High Q, Ultra-low ESR, Non-Magnetic

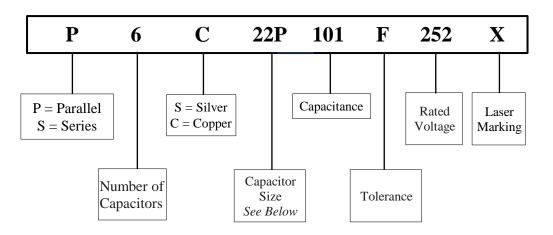
\neq Typical Applications Field

High Power RF, Medical Electronics, Broadcast, Semiconductor Manufacturing, High Magnetic Environments, Inductive Heating



Marking shown for illustration purposes only. Actual marking may differ.

茾 Part Numbering



Capacitor Size: 11P = 1111; 22P = 2225; 38P = 3838; 60P = 6040; 76P = 7676

Capacitance: For capacitor values requiring 3 significant digits,

e.g. 1222.5pF =1222R5

e.g. P6S22P101F252X

Silver bracket assembly with six 2225C pieces in parallel, Capacitance is 100pF, Capacitance tolerance is $\pm 1\%$, WVDC is 2500 V and Laser marking.

e.g. S2S25C1222R5G203X

Silver bracket assembly with two 2225C pieces in series, Capacitance is 1222.5pF,

Capacitance tolerance is ±2%, WVDC is 20,000V and Laser marking.

Capacitance and Voltage

By Buyer's requirements using existing drawings, mechanical sketches, or we can help with capable modeling of assemblies thermal rise predictions.



PPICUSTOMASSEMBLIES042122RevA

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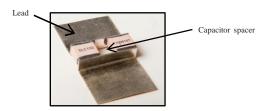
Parallel Assemblies

| | | | | | | unit:inch (millimeter) |
|---|--|-------------------|----------|--------------|----------------|----------------------------|
| | 1111C/P | 22225C/P | 383 | 8C/P | 6040C | 7676C |
| Lead Material | | Silver | plated C | Copper or | Silver | |
| Lead Thickness | .004 0 | or .010 (0.1 or 0 |).25) | | .010 or .02 | 20 (0.25 or 0.51) |
| Lead Length (max.) | .50 (12.7) | .75 (| 19.8) | | 2.0 | 0 (50.8) |
| Capacitor Spacer (typ.) | .050 |) or .078 (1.3 or | 2) | | .090 (2.3) | .050 or .157 (1.3 or 4) |
| Mounting Configuration | | Н | orizonta | ul / Vertica | al | |
| Capacitor spacer | H | | 3838 S | eries/Paral | lel Combinatio | 'n |
| Lead ↓ | Marking shown for illustration purposes only. Actual marking may differ. | | | | | |
| | | | | | | unit:inch (millimeter) |
| | 22225C/P | 3838C/ | | | 40C | 7676C |
| Lead Type | | | L Br | acket | | |
| Lead Material | | Silver p | lated C | opper or | Silver | |
| Lead Thickness | .010 (0.25) .010 or .020 (0.25 or 0.51) | | | | | .25 or 0.51) |
| Lead Length (max.) | .75 (19.8) 1.0 (25.4) | | | | | |
| Capacitor Spacer (typ.) .050 or .157 (1.3 or 4) | | | | | | |
| Mounting Configuration Horizontal | | | | | | |

• Epoxy Molding Available



Other Assemblies: By Buyer's requirement. Contact PPI.



Marking shown for illustration purposes only. Actual marking may differ.



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Product Features

- Lowest ESR
- Low Noise
- High Self-Resonance

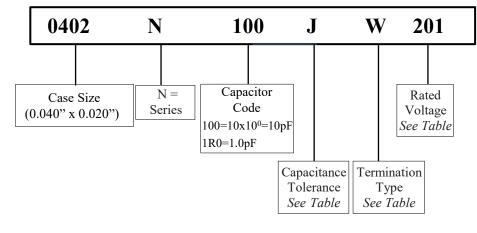
Product Applications

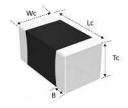
- **Typical Functional Applications**
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines

Part Numbering





Case Size (Chip) Dimensions

| | 0201 | 0402 | 0603 | 0805 | 1111 |
|--------------------------|-------------------|-------------------|----------------------------------|-------------------|-------------------------|
| Longth (L) | 0.024 ± 0.001 | 0.040 ± 0.004 | 0.062 ± 0.006 | 0.080 ± 0.008 | 0.110 + 0.020 to -0.010 |
| Length (L _c) | (0.60 ± 0.03) | (1.02 ± 0.10) | (1.57 ± 0.15) | (2.03±0.20) | (2.79 +0.51 to -0.25) |
| \mathbf{W} | 0.012 ± 0.001 | 0.020 ± 0.004 | 0.032 ± 0.006 | 0.050 ± 0.008 | 0.110 ± 0.015 |
| Width (W _c) | (0.30 ± 0.03) | (0.51 ± 0.10) | (0.81 ± 0.15) | (1.27 ± 0.20) | (2.79 ± 0.38) |
| Thickness | 0.012 ± 0.001 | 0.020 ± 0.004 | $0.030 \pm 0.005 \text{-} 0.003$ | 0.040 ± 0.006 | 0.10 |
| (T_c) | (0.30 ± 0.03) | (0.51 ± 0.10) | $(0.76 \pm 0.20 - 0.08)$ | (1.02±0.15) | (2.60) max |
| $O_{\rm rest} = (D)$ | 0.008 | 0.010 ± 0.006 | $0.014 {\pm} 0.006$ | $0.020{\pm}0.010$ | 0.015 |
| Overlap (B) | (0.20) | (0.25±0.15) | (0.35±0.15) | (0.50 ± 0.25) | (0.024) max |



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† Temperature Coefficient

 $N: 0\pm 30 ppm/^{\circ}C$

† Rated Capacitance

Capacitance is less than 10pF; for example: 1R0=1.0pF, R denotes decimal point Capacitance greater than 10pF; for example: 101=100pF, the third number is the power of 10

† Tolerance

| | Capacitance Tolerance | | | | | | | | | |
|-----------|-----------------------|--------|---------|--------|-----|-----|-----|------|--|--|
| Code | A | В | C | D | F | G | J | K | | |
| Tolerance | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% | | |

† Termination Types and Codes

| Termination Code | Туре | Magnetic Termination |
|---------------------|------|--|
| W ROHS | Chip | 100% Sn Solder over Nickel Plating |
| L | Chip | 90% Sn10%Pb Tin/Lead Solder over Nickel Plating |

† Voltages

| Code | Rated Voltage |
|------|----------------------|
| 250 | 25V |
| 500 | 50V |
| 251 | 250V |
| 501 | 500V |
| 102 | 1000V |





茾 Laser Marking

An "X" at the end of the part number indicates the part is marked.

Laser Marking is available on the 0805N & 1111N case sizes.

Packing Orientation Option

TV: Tape carrier packaging Vertical Orientation.

Vertical orientation means that if the part is lifted from the tape without any rotation and placed on a substrate, its electrodes will be perpendicular to the substrate plane. This impacts the frequency of First Parallel Resonance (suckout).

Performance Requirements

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

All products are in compliance with RoHS instruction.



0201N (0.020" x 0.010")

Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 100pF
- Working Voltage: 50V

茾 Part Numbering

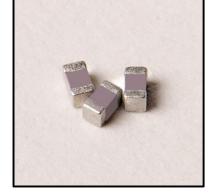
Product Applications

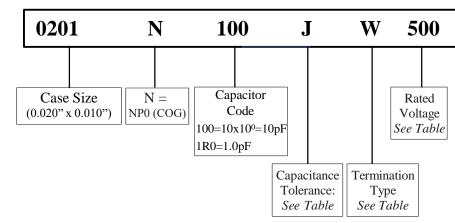
Typical Functional Applications

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications

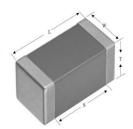
- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines





Capacitor Dimensions Unit: inch (millimeter)

| Code | Term. | Length | Width | Thickness | Overlap |
|------|-------|---|---|-----------------------------------|-----------------|
| | | Lc | Wc | Tc | В |
| W | Chip | $\begin{array}{c} 0.024 \pm 0.001 \\ (0.60 \pm 0.03) \end{array}$ | $\begin{array}{c} 0.012 \pm 0.001 \\ (0.30 \pm 0.03) \end{array}$ | 0.012 ± 0.001 (0.30 ±0.03) | 0.008 (0.20) |



Capacitance Tolerance Codes

| Code | Α | В | С | D | F | G | J | K |
|------|---------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |



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0201N (0.020" x 0.010")

| † ' | Terminat | ions | Type and Code | ÷ | es | | |
|----------------|---------------------|------|----------------------------|---|---------|------|--|
| | Termination Code | | Termination | | Voltage | Code | |
| - | W | 1 | 100% Sn | | 25V | 250 | |
| _ | | RoHS | Solder over Nickel Plating | | 50V | 500 | |



÷ 0201N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

| Cap. | Сар | | Rated | WVDC | Cap. | Сар | | Rated | WVDC | Cap. | Сар | | Rated | WVD |
|------|------|------------|-------|------|------|------|-------------|-------|------|------|------|-------------|-------|------|
| рF | Code | Tol. | Std. | Ext. | pF | Code | Tol. | Std. | Ext. | рF | Code | Tol. | Std. | Ext. |
| 0.1 | OR1 | | | | 2.2 | 2R2 | | | | 16 | 160 | | | |
| 0.2 | OR2 | | | | 2.4 | 2R4 | | | | 18 | 180 | | | |
| 0.3 | OR3 | | | | 2.7 | 2R7 | | | | 20 | 200 | | | |
| 0.4 | OR4 | | | | 3.0 | 3R0 | | | | 22 | 220 | | | |
| 0.5 | OR5 | | | | 3.3 | 3R3 | А,В, С, | 25V | 50V | 24 | 240 | | | |
| 0.6 | OR6 | | | | 3.6 | 3R6 | С, | | | 27 | 270 | | | |
| 0.7 | 0R7 | | | | 3.9 | 3R9 | | | | 30 | 300 | | | |
| 0.8 | 0R8 | | | | 4.3 | 4R3 | | | | 33 | 330 | F,G, J,K | 25V | 50V |
| 0.9 | 0R9 | | | | 4.7 | 4R7 | | | | 36 | 360 | | | |
| 1.0 | 1R0 | | | | 5.1 | 5R1 | B,C, D | | | 39 | 390 | | | |
| 1.1 | 1R1 | А,В, С, | 25V | 50V | 5.6 | 5R6 | | | | 43 | 430 | | | |
| 1.2 | 1R2 | С, | | | 6.2 | 6R2 | | | | 47 | 470 | | | |
| 1.3 | 1R3 | | | | 6.8 | 6R8 | | 25V | 50V | 51 | 510 | | | |
| 1.4 | 1R4 | | | | 7.5 | 7R5 | | | | 56 | 560 | | | |
| 1.5 | 1R5 | | | | 8.2 | 8R2 | | | | 62 | 620 | | | |
| 1.6 | 1R6 | | | | 9.1 | 9R1 | | | | 68 | 680 | | | |
| 1.7 | 1R7 | | | | 10 | 100 | F,G, J,K | | 50V | 75 | 750 | | | |
| 1.8 | 1R8 | | | | 11 | 110 | | | | 82 | 820 | | | |
| 1.9 | 1R9 | | | | 12 | 120 | | 25V | | 91 | 910 | | | |
| 2.0 | 2R0 | | | | 13 | 130 | 3,11 | | | 100 | 101 | | | |
| 2.1 | 2R1 | | | | 15 | 150 | | | | | | | | |



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0201N (0.020" x 0.010")

Electrical Specifications

| Quality Factor (Q) | 2,000 at 1 MHz min. | | | |
|--|---|--|--|--|
| Insulation Resistance (IR) | 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC | | | |
| Rated Voltage | 25V or 50V | | | |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds | | | |
| Operating Temperature Range | -55°C to 175°C | | | |
| Temperature Coefficient (TC) | 0±30ppm/°C | | | |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater | | | |
| Piezoelectric Effects | None | | | |

+ Environmental Specifications

| | Specification | Test Parameters | | | | |
|---------------------------------|--|--|--|--|--|--|
| Thermal Shock | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >10 G Ohms Q>2000 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. | | | | |
| Humidity (Steady State) | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >1 G Ohms Q>300 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 106 | | | | |
| Low Voltage Humidity | No mechanical damage | MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. | | | | |
| Life | No mechanical damage Capacitance Change: ±2.0% or 0.5pF max IR: >1 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors | | | | |
| Terminal Adhesion | Termination should not pull off. Ceramic should remain undamaged | Linear pull force exerted on axial leads soldered to each terminal 2.0lbs. | | | | |
| Resistance to Soldering Heat | No mechanical damage Capacitance Change: -1.0%~+2.0% IR: >10 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | Preheat device to 150° C - 180° C for 60 seconds. Dip in 260° C $\pm 5^{\circ}$ C solder for 10 ± 1 second. Measure after 24 ± 2 hour cooling period. | | | | |

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

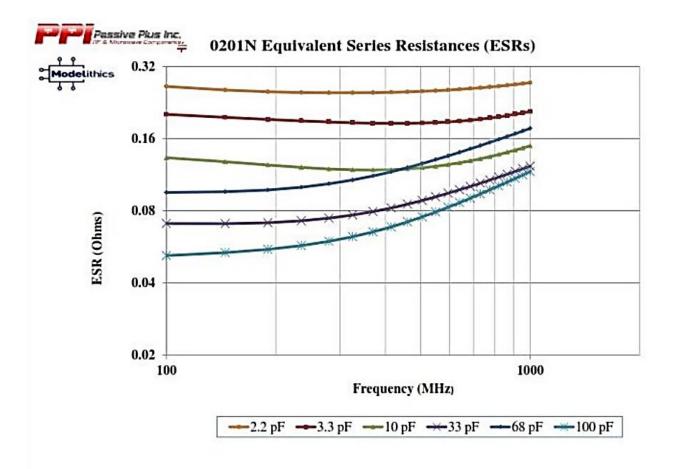


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0201N (0.020" x 0.010")

+ ESR vs. Frequency





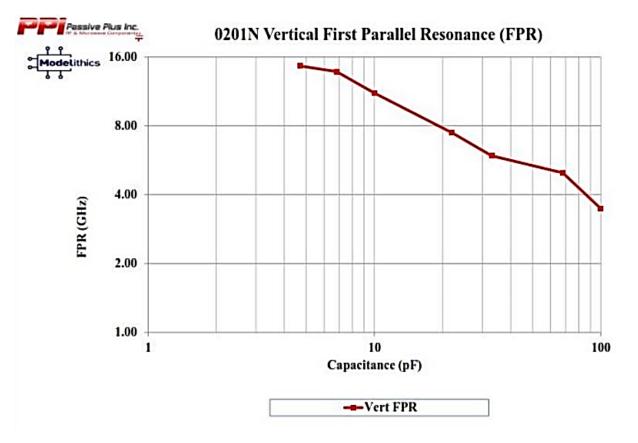
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0201N (0.020" x 0.010")

First Parallel Resonance



÷ Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3006; substrate dielectric constant = 6.15; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 6.0; microstrip trace width (mils) = 14.1; Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



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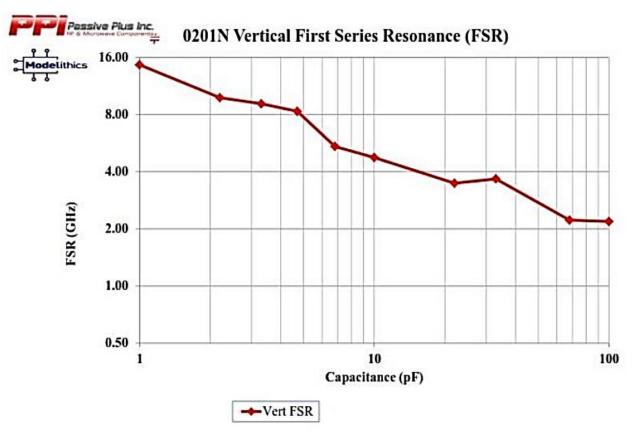
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0201N (0.020" x 0.010")

First Series Resonance



Definitions and Measurement Conditions

The **First Series Resonance, FSR,** is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3006; substrate dielectric constant = 6.15; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 6.0; microstrip trace width (mils) = 14.1; Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



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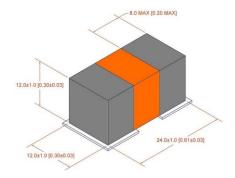
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Capacitor Application Program

Passive Plus, Inc.'s brand new **online Capacitor Application Program** (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models, by either visiting the <u>Passive Plus Resources page</u> (<u>http://passiveplus.com/addldocs_resources.php</u>).

#Modelithics®





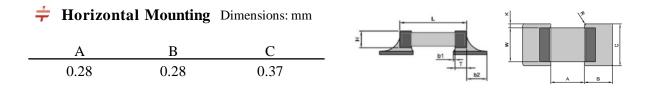
0201N (0.020" x 0.010")

Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

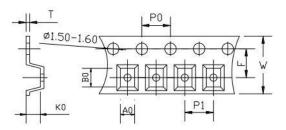
1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.



Tape & Reel Specifications Dimensions: mm

Horizontal Orientation



Dimensions: mm

| Orientation | A0 | B 0 | K0 | W | P0 | P1 | Т | F | Qty Min | Qty/ reel | Tape Material |
|-------------|-------|------------|-------|------|-----------|------|------|------|---------|--------------|------------------|
| Horizontal | 0.406 | 0.749 | 0.422 | 8.00 | 4.00 | 2.00 | 0.42 | 3.50 | 500 | 500 | Paper |



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0201N (0.020" x 0.010")

≠ Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are 100% RoHS compliant.



| Kit Number | Value Range | Values | |
|------------|----------------|---|------|
| DKD0201N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.5, 0.7, 0.8, 0.9, 1.0, 1.3, 1.5, 1.7, 1.9, 2.0pF | RoHS |
| DKD0201N02 | 1.0 - 10pF | 1.0, 1.3, 1.5, 1.7, 1.9, 2.0, 2.2, 2.7, 3.0, 3.9, 4.7, 5.6, 6.8, 7.5, 8.2, 10pF | ROHS |
| DKD0201N03 | 10 - 100pF | 10, 13, 15, 18, 20, 22, 27, 30, 39, 47, 56, 68, 75, 82, 91, 100pF | ROHS |





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0402N (0.040" x 0.020")

Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 33pF

Part Numbering

• Working Voltage: 200V

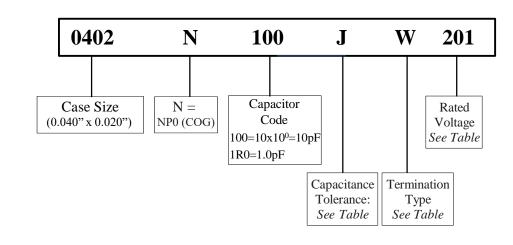
+ + Product Applications

- **Typical Functional Applications**
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications

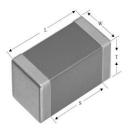
- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines





† Capacitor Dimensions Unit: inch (millimeter)

| Code | Term. | Length | Width | Thickness | Overlap | |
|------|-------|---|---|---|----------------------------|--|
| | | Lc | Wc | Тс | В | |
| W | Chip | $\begin{array}{c} 0.040 \pm 0.004 \\ (1.02 \pm 0.10) \end{array}$ | $\begin{array}{c} 0.020 \pm 0.004 \\ (0.51 \pm 0.10) \end{array}$ | $\begin{array}{c} 0.020 \pm 0.004 \\ (0.51 \pm 0.10) \end{array}$ | 0.010±0.006 (0.25±0.15) | |



÷ Capacitance Tolerance Codes

| Code | Α | В | С | D | F | G | J | K |
|------|---------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |



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0402N (0.040" x 0.020")

| tions | ≠ Voltage Code | | | |
|-------|----------------------------|---------|--------------------------------|---------------------------------------|
| | Termination | | Voltage | |
| 1 | 100% Sn | | 50V | |
| RoHS | Solder over Nickel Plating | | 200V | |
| | tion | 100% Sn | tion Termination 100% Sn | tion Termination 100% Sn 50V |

| Voltage | Code |
|---------|------|
| 50V | 500 |
| 200V | 201 |
| 250V | 251 |
| | |



÷ 0402N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

| Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | Rated | WVDC | | | | | | | | | | | | | | | | | | | | | | | | |
|------|------|------|-----------|----------------|------|------|-------------|-----------|-------|------|------|-------------|-------|-----------|-----|-----|--|------|--|----|-----|--|--|--|--|--|--|--|-----|-----|--|--|----|--|-----|--|--|--|
| рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. | | | | | | | | | | | | | | | | | | | | | | | | |
| 0.1 | OR1 | | | | 1.7 | 1R7 | А,В, | 50V | | 6.8 | 6R8 | | 501/ | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0.2 | OR2 | | | | 1.8 | 1R8 | А,В, С,D | or | | 250V | 7.5 | 7R5 | А,В, | 50V or | N/A | | | | | | | | | | | | | | | | | | | | | | | |
| 0.3 | OR3 | | | | 1.9 | 1R9 | | 200V | | 8.2 | 8R2 | С | 200V | ,,, | | | | | | | | | | | | | | | | | | | | | | | | |
| 0.4 | OR4 | | | | 2.0 | 2R0 | | | | 9.1 | 9R1 | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0.5 | OR5 | | | 2.1 2R1 | | | 10 | 100 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0.6 | OR6 | | | | 2.2 | 2R2 | | 50V | 50V | | 11 | 110 | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0.7 | OR7 | | 501/ | | | or | 250V | 12 | 2 120 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0.8 | OR8 | А,В, | 50V or | | | , or | | 50V or | | | | | | 250V | 2.7 | 2R7 | | 200V | | 13 | 130 | | | | | | | | | | | | | | | | | |
| 0.9 | OR9 | C,D | 200V | 2300 | 3.0 | 3R0 | | | | 15 | 150 | ГC | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1.0 | 1R0 | | | | 3.3 | 3R3 | | | | 16 | 160 | F,G, J,K | | N/A | | | | | | | | | | | | | | | | | | | | | | | | |
| 1.1 | 1R1 | | | | 3.6 | 3R6 | | | | 18 | 180 | | 200V | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1.2 | 1R2 | | | | | | | | | | | | | | | | | | | | | | | | | | | | 3.9 | 3R9 | | | 20 | | 200 | | | |
| 1.3 | 1R3 | | | | 4.3 | 4R3 | | 50V | | 22 | 220 | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1.4 | 1R4 | | | | 4.7 | 4R7 | А,В, С,D | or | N/A | 24 | 240 | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1.5 | 1R5 | | | | 5.1 | 5R1 | , | 200V | | 27 | 270 | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1.6 | 1R6 | | | | 5.6 | 5R6 | | | | 30 | 300 | F,G, | 50V | N/A | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | | | 6.2 | 6R2 | | | | 33 | 330 | J,K | 500 | | | | | | | | | | | | | | | | | | | | | | | | | |



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PPI0402NDATA063022RevA



0402N (0.040" x 0.020")

Electrical Specifications

| Quality Factor (Q) | 2,000 at 1 MHz min. |
|--|---|
| Insulation Resistance (IR) | 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC |
| Rated Voltage | See Rated Voltage |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds |
| Operating Temperature Range | -55°C to 175°C |
| Temperature Coefficient (TC) | 0±30ppm/°C |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater |
| Piezoelectric Effects | None |

† Environmental Specifications

| | Specification | Test Parameters |
|---------------------------------|--|--|
| Thermal Shock | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >10 G Ohms Q>2000 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Humidity (Steady State) | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >1 G Ohms Q>300 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 106 |
| Low Voltage Humidity | No mechanical damage | MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | No mechanical damage Capacitance Change: ±2.0% or 0.5pF max IR: >1 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors |
| Terminal Adhesion | Termination should not pull off. Ceramic should remain undamaged | Linear pull force exerted on axial leads soldered to each terminal 2.0lbs. |
| Resistance to Soldering Heat | No mechanical damage Capacitance Change: -1.0%~+2.0% IR: >10 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | Preheat device to 150° C - 180° C for 60 seconds. Dip in 260° C $\pm 5^{\circ}$ C solder for 10 ± 1 second. Measure after 24 ± 2 hour cooling period. |

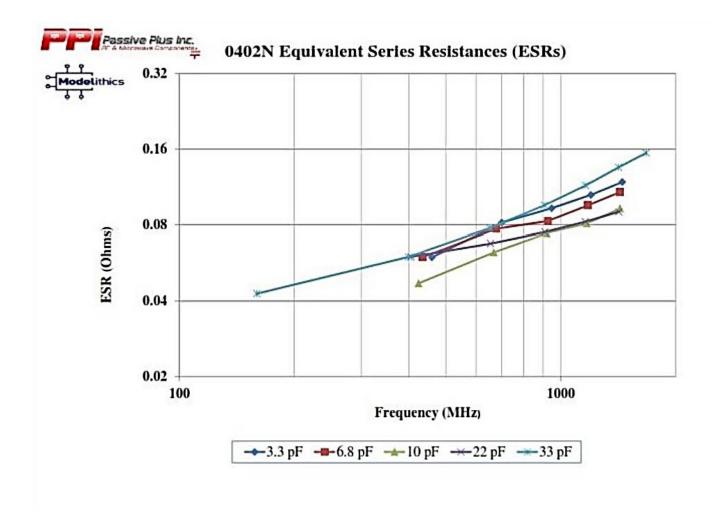
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.





0402N (0.040" x 0.020")

÷ ESR vs. Frequency





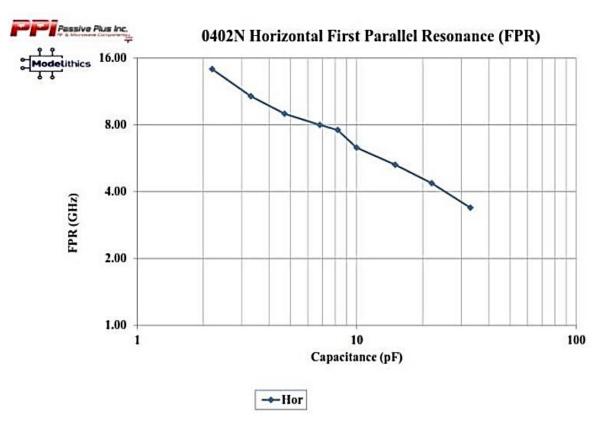
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PPI0402NDATA063022RevA



0402N (0.040" x 0.020"

First Parallel Resonance



÷ Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.48; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 15; microstrip trace width (mils) = 22; Reference planes at sample edges.

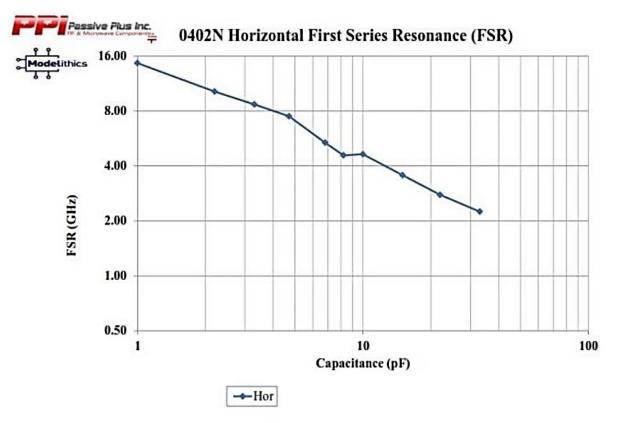
All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.





0402N (0.040" x 0.020"

First Series Resonance



† Definitions and Measurement Conditions

The **First Series Resonance, FSR,** is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.48; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 15; microstrip trace width (mils) = 22; Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



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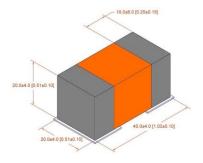
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Capacitor Application Program

Passive Plus, Inc.'s brand new **online Capacitor Application Program** (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models, by either visiting the <u>Passive Plus Resources page</u> (<u>http://passiveplus.com/addldocs_resources.php</u>).

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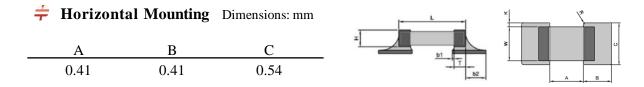
0402N (0.040" x 0.020"

Free Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

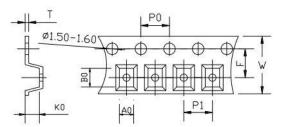
1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.



Tape & Reel Specifications Dimensions: mm

Horizontal Orientation



| Orientation | A0 | BO | K0 | W | P0 | P1 | Т | F | Qty Min | Qty/ reel | Tape Material |
|-------------|------|------|------|------|------|------|------|------|---------|--------------|------------------|
| Horizontal | 0.60 | 1.10 | 1.00 | 8.00 | 4.00 | 2.00 | 0.20 | 3.50 | 500 | 500 | Paper |



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Multi-Layer Ceramic Capacitors

EIA Low ESR





0402N (0.040" x 0.020")

🗧 Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are 100% RoHS compliant.



| Kit Number | Value Range | Values | |
|------------|----------------|---|------|
| DKD0402N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF | ROHS |
| DKD0402N02 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF | ROHS |
| DKD0402N03 | 10 - 33pF | 10, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33pF | ROHS |





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PPI0402NDATA063022RevA

0603N (0.060" x 0.030")

Product Features

- High Q •
- High Power •
- Low ESR/ESL
- Low Noise
- High Self-Resonance •
- Ultra Stable Performance
- Capacitance Range: • 0.1pF to 100pF
- Working Voltage: 250V

\neq Product Applications

- **Typical Functional Applications**
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

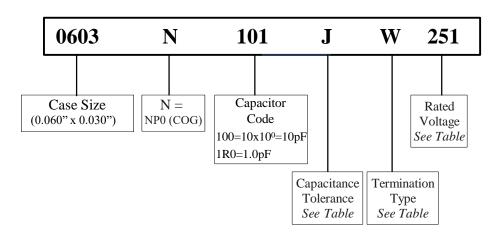
Typical Circuit Applications

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



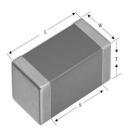


茾 Part Numbering



‡ Capacitor Dimensions Unit: inch (millimeter)

| (| Code | Term. | Length | Width | Thickness | Overlap |
|---|------|-------|---|-------|--|---------|
| | | | Lc | Wc | Тс | В |
| | W | Chip | $\begin{array}{c} 0.062 \pm 0.006 \\ (1.57 \pm 0.15) \end{array}$ | | $\begin{array}{c} 0.030 \pm 0.005 0.003 \\ (0.76 \pm 0.20 0.08) \end{array}$ | |



\neq Capacitance Tolerance Codes

| Code | Α | В | С | D | F | G | J | K |
|------|---------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |



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0603N (0.060" x 0.030")

| Terminatio | ons | Types and Codes |
|--------------------|------|---------------------------------------|
| Terminatio Code | n | Termination |
| W | RoHS | 100% Sn Solder over Nickel Plating |
| L | | 90% Sn10% Pb Tin/Lead |

| 茾 Voltage C | ode |
|-------------|-----|
|-------------|-----|

 Voltage
 Code

 250V
 251



÷ 0603N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

| Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC |
|------------|-------------|------|---------------|------------|-------------|------|---------------|------------|-------------|-----------|---------------|------------|-------------|------|---------------|
| 0.1 | OR1 | | | 1.7 | 1R7 | | | 6.2 | 6R2 | | | 30 | 300 | | |
| 0.2 | OR2 | | | 1.8 | 1R8 | | | 6.8 | 6R8 | | | 33 | 330 | | |
| 0.3 | OR3 | | | 1.9 | 1R9 | | | 7.5 | 7R5 | А,В, С | 250V | 36 | 360 | | |
| 0.4 | 0R4 | | | 2.0 | 2R0 | | | 8.2 | 8R2 | | | 39 | 390 | | |
| 0.5 | OR5 | | | 2.1 | 2R1 | | | 9.1 | 9R1 | | | 43 | 430 | | |
| 0.6 | OR6 | | | 2.2 | 2R2 | | | 10 | 100 | | | 47 | 470 | | |
| 0.7 | 0R7 | | | 2.4 | 2R4 | | | 11 | 110 | | | 51 | 510 | F,G, | 250V |
| 0.8 | OR8 | А,В, | 250V | 2.7 | 2R7 | А,В, | 250V | 12 | 120 | | | 56 | 560 | J,K | |
| 0.9 | OR9 | C,D | | 3.0 | 3R0 | C,D | | 13 | 130 | | | 62 | 620 | | |
| 1.0 | 1R0 | | | 3.3 | 3R3 | | | 15 | 150 | F,G, | | 68 | 680 | | |
| 1.1 | 1R1 | | | 3.6 | 3R6 | | | 16 | 160 | J,K | 250V | 75 | 750 | | |
| 1.2 | 1R2 | | | 3.9 | 3R9 | | | 18 | 180 | | | 82 | 820 | | |
| 1.3 | 1R3 | | | 4.3 | 4R3 | | | 20 | 200 | | | 91 | 910 | | |
| 1.4 | 1R4 | | | 4.7 | 4R7 | | | 22 | 220 | | | 100 | 101 | | |
| 1.5 | 1R5 | | | 5.1 | 5R1 | | | 24 | 240 | | | | | | |
| 1.6 | 1R6 | | | 5.6 | 5R6 | | | 27 | 270 | | | | | | |



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PPI0603NDATA063022RevA



0603N (0.060" x 0.030")

Electrical Specifications

| Quality Factor (Q) | 2,000 at 1 MHz min. |
|--|---|
| Insulation Resistance (IR) | 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC |
| Rated Voltage | 250V |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds |
| Operating Temperature Range | -55°C to 175°C |
| Temperature Coefficient (TC) | 0±30ppm/°C |
| Capacitance Drift | $\pm 0.02\%$ or $\pm 0.02 \text{pF}$, whichever is greater |
| Piezoelectric Effects | None |

÷ Environmental Specifications

| | Specification | Test Parameters |
|---------------------------------|--|--|
| Thermal Shock | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >10 G Ohms Q>2000 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Humidity (Steady State) | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >1 G Ohms Q>300 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 106 |
| Low Voltage Humidity | No mechanical damage | MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | No mechanical damage Capacitance Change: ±2.0% or 0.5pF max IR: >1 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors |
| Terminal Adhesion | Termination should not pull off. Ceramic should remain undamaged | Linear pull force exerted on axial leads soldered to each terminal 2.0lbs. |
| Resistance to Soldering Heat | No mechanical damage Capacitance Change: -1.0%~+2.0% IR: >10 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | Preheat device to 150° C - 180° C for 60 seconds. Dip in 260° C $\pm 5^{\circ}$ C solder for 10 ± 1 second. Measure after 24 ± 2 hour cooling period. |

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

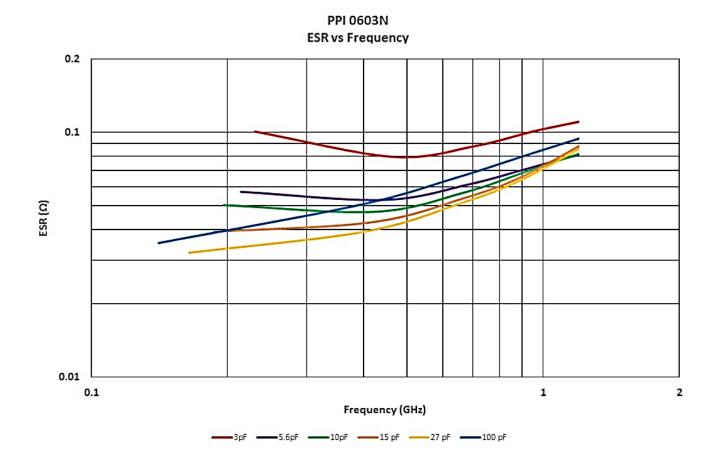


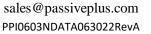
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0603N (0.060" x 0.030")

ESR vs. Frequency



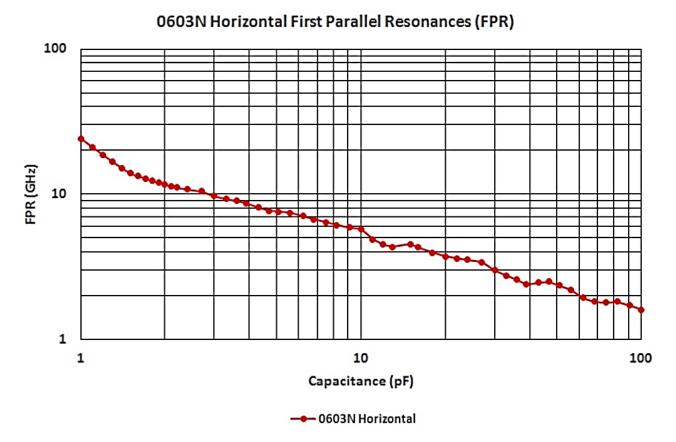


Passive Plus Inc. RF & Microwave Components



0603N (0.060" x 0.030")

First Parallel Resonance



÷ Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RT/duriod® 5880; substrate dielectric constant = 2.20; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 23.7; microstrip trace width (mils) = 30.0; Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



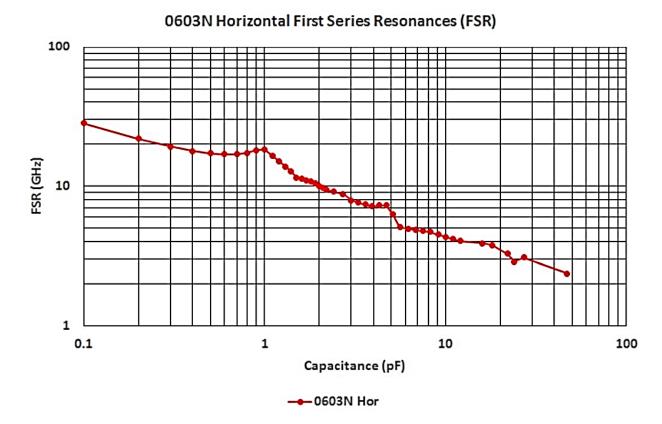
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0603N (0.060" x 0.030"

First Series Resonance



+ Definitions and Measurement Conditions

The **First Series Resonance**, **FSR**, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RT/duriod® 5880; substrate dielectric constant = 2.20; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 23.7; microstrip trace width (mils) = 30.0; Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



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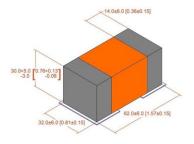
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Capacitor Application Program

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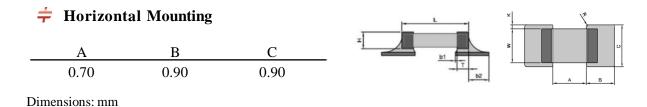
0603N (0.060" x 0.030"

; **Recommended Land Pattern Dimensions**

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

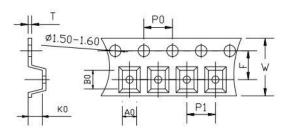
1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.



Tape & Reel Specifications Dimensions: mm





| Orientation | A0 | B0 | K0 | W | PO | P1 | Т | F | Qty Min | Qty/ reel | Tape Material |
|---------------|------|------|------|------|------|------|------|------|---------|--------------|------------------|
| Horizontal | 0.95 | 1.80 | 0.85 | 8.00 | 4.00 | 4.00 | 0.20 | 3.50 | 500 | 500 | Paper |
| Dimensions: m | nm | | | | | | | | | | |



ALLER CONTRACTOR

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0603N (0.060" x 0.030")

茾 Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are 100% RoHS compliant.



| Kit Number | Value Range | Values | |
|------------|----------------|--|------|
| DKD0603N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.1, 1.2, 1.5, 1.6, 1.8, 2.0pF | ROHS |
| DKD0603N02 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF | ROHS |
| DKD0603N03 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 100pF | ROHS |





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0805N (0.080" x 0.050")

Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 220pF

F **Product Applications**

- **Typical Functional Applications**
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

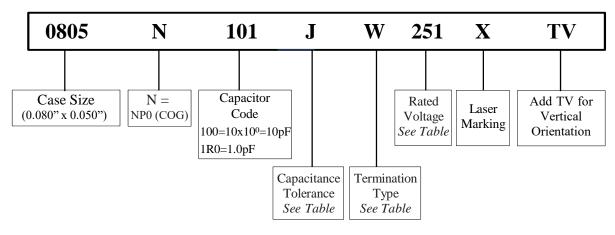
Typical Circuit Applications

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



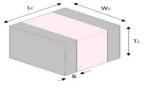
Marking shown for illustration purposes only. Actual marking may differ.

≠ Part Numbering



Capacitor Dimensions Unit: inch (millimeter)

| Code | Term. | Length | Width | Thickness | Overlap |
|------|-------|---|---|----------------------------|----------------------------|
| | | Lc | Wc | Tc | В |
| W | Chip | 0.080 ± 0.008 (2.03 ± 0.20) | $\begin{array}{c} 0.050 \pm 0.008 \\ (1.27 \pm 0.20) \end{array}$ | 0.040±0.006 (1.02±0.15) | 0.020±0.010 (0.50±0.25) |



Capacitance Tolerance Codes

| Code | Α | В | С | D | F | G | J | К |
|------|---------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |



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0805N (0.080" x 0.050")

| Terminat | ions | Types and Codes |
|------------------|------|---------------------------------------|
| Terminat Code | ion | Termination |
| W | ROHS | 100% Sn Solder over Nickel Plating |
| L | | 90% Sn10% Pb Tin/Lead |

| <i>‡</i> Voltage | Code |
|--------------------------------|------|
|--------------------------------|------|

| Voltage | Code |
|---------|------|
| 250V | 251 |
| | |



≠ 0805N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

| Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC | |
|------------|-------------|------|---------------|------------|-------------|-------------|---------------|------------|-------------|------|---------------|------------|-------------|---------|---------------|--|
| 0.1 | OR1 | | | 2.1 | 2R1 | | | 13 | 130 | | | 91 | 910 | | | |
| 0.2 | 0R2 | | | 2.2 | 2R2 | | 15 | 150 | | | 100 | 101 | | | | |
| 0.3 | OR3 | | | 2.4 | 2R4 | | | 16 | 160 | | | 110 | 111 | | | |
| 0.4 | 0R4 | | | 2.7 | 2R7 | | | 18 | 180 | | | 120 | 121 | | | |
| 0.5 | OR5 | | | 3.0 | 3R0 | | | 20 | 200 | | | 130 | 131 | F,G,J,K | 250V | |
| 0.6 | OR6 | | | 3.3 | 3R3 | | | 22 | 220 | | | 150 | 151 | 1,0,3,1 | 2500 | |
| 0.7 | 0R7 | | | 3.6 | 3R6 | А,В, С,D | 250V | 24 | 240 | | | 160 | 161 | | | |
| 0.8 | OR8 | | | 3.9 | 3R9 | | | 27 | 270 | | | 180 | 181 | | | |
| 0.9 | 0R9 | | | 4.3 | 4R3 | | | | 30 | 300 | | | 200 | 201 | | |
| 1.0 | 1R0 | А,В, | 250V | 4.7 | 4R7 | | | 33 | 330 | F,G, | 250V | 220 | 221 | | | |
| 1.1 | 1R1 | C,D | 2001 | 5.1 | 5R1 | | | 36 | 360 | J,K | 2001 | | | | | |
| 1.2 | 1R2 | | | 5.6 | 5R6 | | | 39 | 390 | | | | | | | |
| 1.3 | 1R3 | | | 6.2 | 6R2 | | | 43 | 430 | | | | | | | |
| 1.4 | 1R4 | | | 6.8 | 6R8 | | | 47 | 470 | | | | | | | |
| 1.5 | 1R5 | | | 7.5 | 7R5 | B,C | 250V | 51 | 510 | | | | | | | |
| 1.6 | 1R6 | | | 8.2 | 8R2 | _,_ | | 56 | 560 | | | | | | | |
| 1.7 | 1R7 | | | 9.1 | 9R1 | | | 62 | 620 | | | | | | | |
| 1.8 | 1R8 | | | 10 | 100 | F,G, | | 68 | 680 | | | | | | | |
| 1.9 | 1R9 | | | 11 | 110 | г,G, Ј,К | 250V | 75 | 750 | | | | | | | |
| 2.0 | 2R0 | | | 12 | 120 | | | 82 | 820 | | | | | | | |



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0805N (0.080" x 0.050")

Electrical Specifications

| Quality Factor (Q) | 2,000 at 1 MHz min. | | | | | | | |
|--|---|--|--|--|--|--|--|--|
| Insulation Resistance (IR) | 10 ⁵ Megaohms min. (a) +25°C rated WVDC 10 ⁴ Megaohms min. (a) +125°C rated WVDC | | | | | | | |
| Rated Voltage | 250V | | | | | | | |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds | | | | | | | |
| Operating Temperature Range | -55°C to 175°C | | | | | | | |
| Temperature Coefficient (TC) | 0±30ppm/°C | | | | | | | |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater | | | | | | | |
| Piezoelectric Effects | None | | | | | | | |

Environmental Specifications

| | Specification | Test Parameters | | | | | | |
|---------------------------------|--|--|--|--|--|--|--|--|
| Thermal Shock | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >10 G Ohms Q>2000 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. | | | | | | |
| Humidity (Steady State) | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >1 G Ohms Q>300 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 106 | | | | | | |
| Life | No mechanical damage | MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC | | | | | | |
| Terminal Adhesion | Termination should not pull off. Ceramic should remain undamaged | Linear pull force exerted on axial leads soldered to each terminal. 2.0lbs. | | | | | | |
| Resistance to Soldering Heat | No mechanical damage Capacitance Change: -1.0%~+2.0% IR: >10 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | Preheat device to 150° C - 180° C for 60 seconds. Dip in 260° C $\pm 5^{\circ}$ C solder for 10 ± 1 second. Measure after 24 ± 2 hour cooling period. | | | | | | |

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

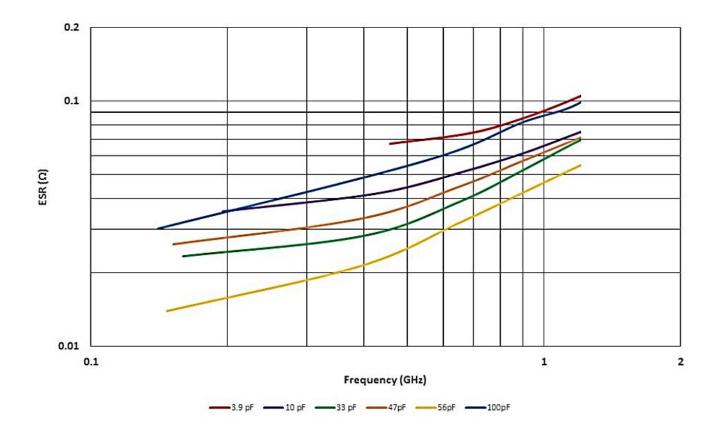


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0805N (0.080" x 0.050")







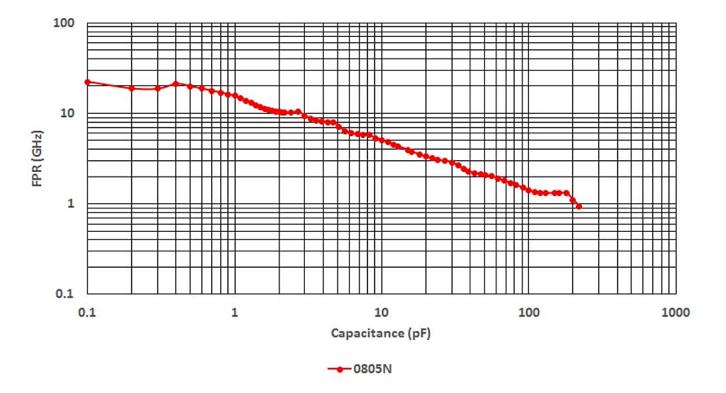
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0805N (0.080" x 0.050")

茾 First Parallel Resonance



÷ Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3003; substrate dielectric constant = 3.00; substrate thickness (mils) = 23; gap in microstrip trace (mils) = 23.6; microstrip trace width (mils) = 57.1; Reference planes at sample edges.

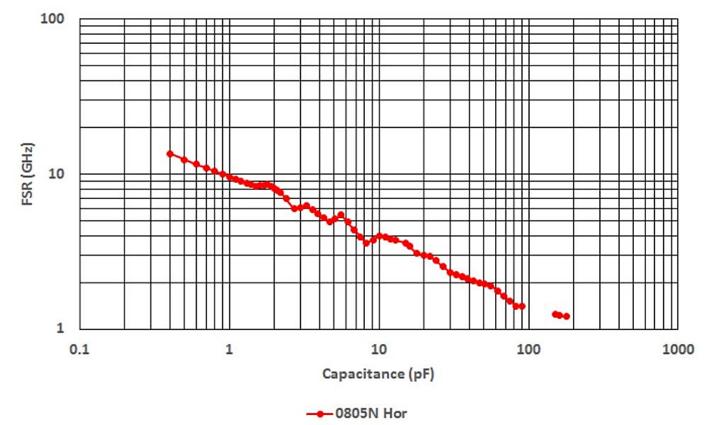
All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.





0805N (0.080" x 0.050")

First Series Resonance



+ Definitions and Measurement Conditions

The **First Series Resonance, FSR,** is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3003; substrate dielectric constant = 3.00; substrate thickness (mils) = 23; gap in microstrip trace (mils) = 23.6; microstrip trace width (mils) = 57.1; Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



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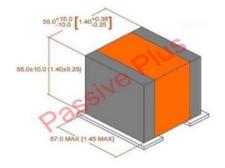
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+ Capacitor Application Program

Passive Plus, Inc.'s brand new **online Capacitor Application Program** (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models, by either visiting the <u>Passive Plus Resources page</u> (<u>http://passiveplus.com/addldocs_resources.php</u>).

#Modelithics®





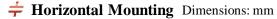
0805N (0.080" x 0.050")

Free Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.





| + | Vertical | Mounting | Dimensions: mm |
|---|----------|----------|----------------|
| | А | В | С |
| | 1.10 | 1.10 | 1.40 |

Ø1.50-1.60

KO

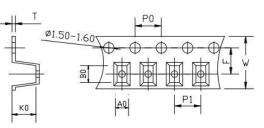
÷

Tape & Reel Specifications Dimensions: mm

AQ

Horizontal Orientation

Vertical Orientation



| Case Size | Orientation | Measurement Unit | W | P0 | P1 | Т | F | Minimum Qty per Reel | Std Qty per Reel | Tape Material |
|-----------|-------------|---------------------|-------|-------|-------|-------|-------|----------------------------|---------------------|------------------|
| | Н | in. | 0.315 | 0.157 | 0.157 | 0.009 | 0.138 | 500 | 3000 | Plastic |
| 0805N | | mm | 8.00 | 4.00 | 4.00 | 0.22 | 3.50 | 500 | 3000 | riastic |
| 08031 | V | in. | 0.315 | 0.157 | 0.157 | 0.009 | 0.138 | 500 | 1000 | Plastic |
| | | mm | 8.00 | 4.00 | 4.00 | 0.22 | 3.50 | 500 | 1000 | Plastic |



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0805N (0.080" x 0.050")

Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are 100% RoHS compliant.



| Kit Number | Value Range | Values | |
|------------|----------------|---|------|
| DKD0805N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF | ROHS |
| DKD0805N02 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF | ROHS |
| DKD0805N03 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF | ROHS |
| DKD0805N04 | 10 - 220pF | 10, 15, 18, 20, 24, 27, 30, 39, 47, 56, 68, 82, 100, 120, 150, 180, 220pF | ROHS |



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Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.2pF to 1000pF

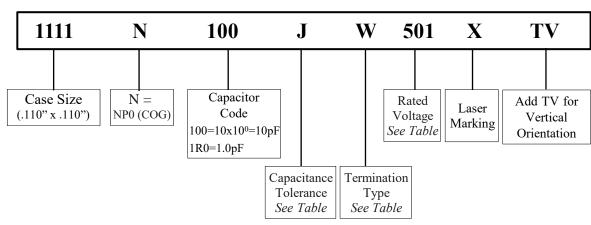
Product Applications

- **Typical Functional Applications**
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines

Part Numbering



Capacitor Dimensions Unit: inch (millimeter)

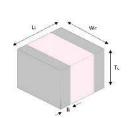
| Code | Term. | Length | Width | Thickness | Overlap |
|------|-------|---|---|--------------------|----------------------|
| | | Lc | Wc | Tc | В |
| W | Chip | 0.110 + 0.020 to -0.010 (2.79 +0.51 to -0.25) | $\begin{array}{c} 0.110 \pm 0.015 \\ (2.79 \pm 0.38) \end{array}$ | 0.10 (2.60 max) | 0.015 (0.024 max) |

Capacitance Tolerance Codes

| Code | Α | В | C D | | F | G | J | K |
|------|---------|--------|---------|--------|-----|-----|-----|------|
| Tol. | ±0.05pF | ±0.1pF | ±0.25pF | ±0.5pF | ±1% | ±2% | ±5% | ±10% |



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Marking shown for illustration purposes only. Actual marking may differ.



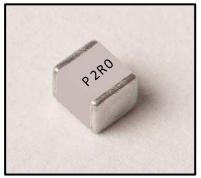
11111N (0.110" x 0.110")

† Terminations Types and Codes

| Terminat Code | ion | Termination | | | | | |
|------------------|------|---------------------------------------|--|--|--|--|--|
| W | Roms | 100% Sn Solder over Nickel Plating | | | | | |
| L | | 90% Sn10% Pb Tin/Lead | | | | | |

† Voltage Code

| Voltage | Code |
|---------|------|
| 100V | 101 |
| 200V | 201 |
| 500V | 501 |
| 1000V | 102 |
| | |



Marking shown for illustration purposes only. Actual marking may differ.

† 1111N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

| Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | Rated | WVDC | Cap. | Сар | Tol. | Rated | WVDC | | | | | | | | | |
|------|------|------|-------|-------|------|------|-------------|------------|----------------|--------|---------|-------|-------|------|------|------|-------------|-------|-------|-------|------|------|-----------|------|------|--|--|--|
| рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. | рF | Code | 101. | Std. | Ext. | | | | | | | | | |
| 0.2 | OR2 | | | | 2.7 | 2R7 | | | | | 22 | 220 | | | | 180 | 181 | F,G, | 500V | 1000V | | | | | | | | |
| 0.3 | OR3 | | | | 3.0 | 3R0 | | | | 24 | 240 | | | | 200 | 201 | J,K | 3001 | 10001 | | | | | | | | | |
| 0.4 | OR4 | | | | 3.3 | 3R3 | | | | 27 | 270 | | | | 220 | 221 | | | | | | | | | | | | |
| 0.5 | OR5 | | | | 3.6 | 3R6 | А,В, С,D | 500V | 1000V | 30 | 300 | | | | 240 | 241 | | | | | | | | | | | | |
| 0.6 | OR6 | | | | 3.9 | 3R9 | 0,2 | | | 33 | 330 | | | | 270 | 271 | | | | | | | | | | | | |
| 0.7 | OR7 | | | | 4.3 | 4R3 | | | | 36 | 360 | | | | 300 | 301 | F,G, J,K | 200V | 500V | | | | | | | | | |
| 0.8 | OR8 | | | | 4.7 | 4R7 | | | | 39 | 390 | | | | 330 | 331 | 5,10 | | | | | | | | | | | |
| 0.9 | OR9 | | | | 5.1 | 5R1 | | 500V 1000V | 43 | 430 | | | | 360 | 361 | | | | | | | | | | | | | |
| 1.0 | 1R0 | | | | 5.6 | 5R6 | | | | 47 | 470 | | | | 390 | 391 | | | | | | | | | | | | |
| 1.1 | 1R1 | | | | 6.2 | 6R2 | | | B,C, D 500V | 5007 1 | 5000 10 | | 51 | 510 | | | | 430 | 431 | G,J, | 200V | 500V | | | | | | |
| 1.2 | 1R2 | А,В, | 500V | 1000V | 6.8 | 6R8 | | | | | | 1000V | 56 | 560 | F,G, | 500V | 1000V | 470 | 471 | К | 2000 | 5000 | | | | | | |
| 1.3 | 1R3 | C,D | 3000 | 10000 | 7.5 | 7R5 | 5 | | | | | | | | | | | | 62 | 620 | J,K | 3000 | 10000 | 510 | 511 | | | |
| 1.4 | 1R4 | | | | 8.2 | 8R2 | | | | | | | | | | 68 | 680 | | | | 560 | 561 | G,J, K | 100V | 500V | | | |
| 1.5 | 1R5 | | | | 9.1 | 9R1 | | | | 75 | 750 | | | | 620 | 621 | N N | | | | | | | | | | | |
| 1.6 | 1R6 | | | | 10 | 100 | | | | 82 | 820 | | | | 680 | 681 | | | | | | | | | | | | |
| 1.7 | 1R7 | | | | 11 | 110 | | | | 91 | 910 | | | | 750 | 751 | | | | | | | | | | | | |
| 1.8 | 1R8 | | | | 12 | 120 | | | | 100 | 101 | | | | 820 | 821 | G,J, K | 50V | N/A | | | | | | | | | |
| 1.9 | 1R9 | | | | 13 | 130 | F,G, | 5001/ | 10001/ | 110 | 111 | | | | 910 | 911 | ĸ | | | | | | | | | | | |
| 2.0 | 2R0 | | | | 15 | 150 | J,K | 500V | 1000V | 120 | 121 | | | | 1000 | 102 | | | | | | | | | | | | |
| 2.1 | 2R1 | | | | 16 | 160 | | | | 130 | 131 | | | | | | | | | | | | | | | | | |
| 2.2 | 2R2 | | | | 18 | 180 | | | | 150 | 151 | | | | | | | | | | | | | | | | | |
| 2.4 | 2R4 | | | | 20 | 200 | | | | 160 | 161 | | | | | | | | | | | | | | | | | |



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PPI1111NDATA063022RevA



1111N (0.110" x 0.110")

Electrical Specifications

| Quality Factor (Q) | 2,000 at 1 MHz min. | |
|--|--|--|
| Insulation Resistance (IR) | 10 ⁵ Megaohms min. @ +25°C rated WVDC 10 ⁴ Megaohms min. @ +125°C rated WVDC | |
| Rated Voltage | See Rated Voltage Table | |
| Dielectric Withstanding Voltage (WVDC) | 250% of Rated Voltage of 5 seconds, Rated Voltage \leq 500VDC 150% of Voltage for 5 seconds, 500VDC <rated <math="" voltage="">\leq 1250 VDC 120% of Voltage for 5 seconds, Rated Voltage > 1250 VDC</rated> | |
| Operating Temperature Range | -55°C to 175°C | |
| Temperature Coefficient (TC) | 0±30ppm/°C | |
| Capacitance Drift | $\pm 0.02\%$ or ± 0.02 pF, whichever is greater | |
| Piezoelectric Effects | None | |

Environmental Specifications

| Specification | | Test Parameters |
|---------------------------------|--|--|
| Thermal Shock | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >1 G Ohms Q>500 | MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles. |
| Moisture Resistance | Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 106 |
| Humidity (Steady State) | No mechanical damage Capacitance Change: ±0.5% or 0.5pF max IR: >1 G Ohms Q>300 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum. |
| Life | No mechanical damage Capacitance Change: ±2.0% or 0.5pF max IR: >1 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC |
| Terminal Adhesion | Termination should not pull off. Ceramic should remain undamaged | Linear pull force exerted on axial leads soldered to each terminal. 2.0lbs. |
| Resistance to Soldering Heat | No mechanical damage Capacitance Change: - 1.0%~+2.0 IR: >1 G Ohms Q>500 Breakdown Voltage: 2.5x WVDC | Preheat device to 150°C -180°C for 60 seconds. Dip in 260°C ±5C solder for 10 ±1 second. Measure after 24± 2 hour cooling period. |

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.



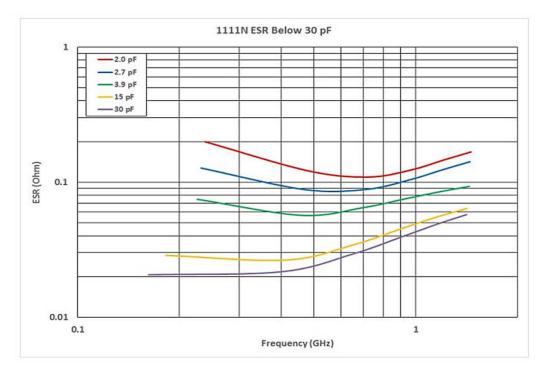
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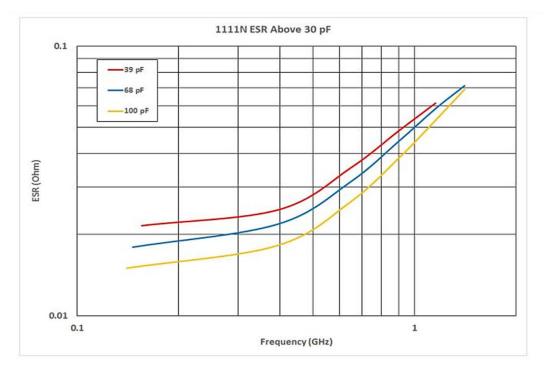
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1111N (0.110" x 0.110")

÷ ESR vs. Frequency







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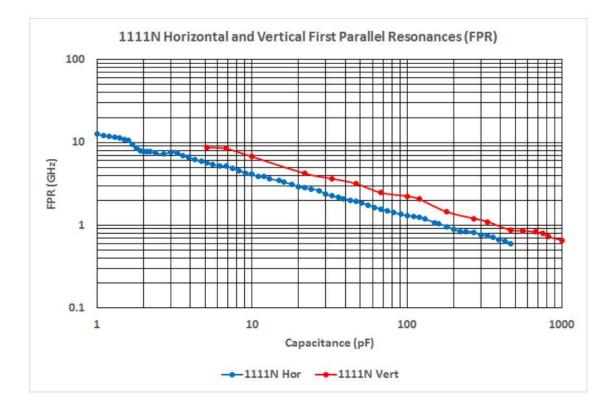
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EIA Low ESR Multi-Layer Ceramic Capacitors

11111N (0.110" x 0.110")

First Parallel Resonance



† Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the carts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with a 50-Ohm termination. The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.48; horizontal mount substrate thickness (mils) = 55; vertical mount substrate thickness (mils) = 45; gap in microstrip trace (mils) = 61.1; horizontal mount microstrip trace width (mils) = 123.7; vertical mount microstrip trace width (mils) = 101.0. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



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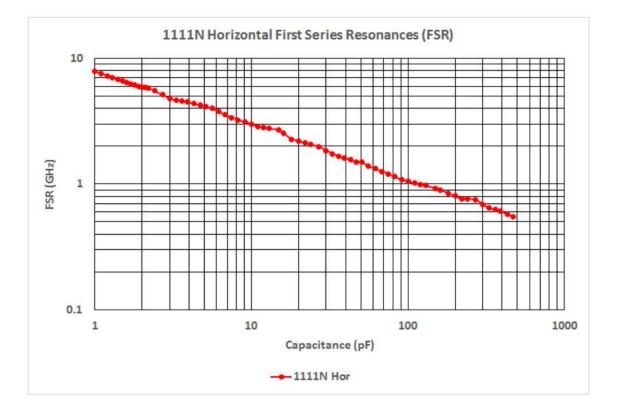
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EIA Low ESR Multi-Laver Ceramic Capacitors

11111N (0.110" x 0.110")

🗧 First Series Resonance



Definitions and Measurement Conditions

The **First Series Resonance**, **FSR**, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] = 0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

The definitions on the carts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with a 50-Ohm termination. The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.48; horizontal mount substrate thickness (mils) = 55; vertical mount substrate thickness (mils) = 45; gap in microstrip trace (mils) = 61.1; horizontal mount microstrip trace width (mils) = 123.7; vertical mount microstrip trace width (mils) = 101.0. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



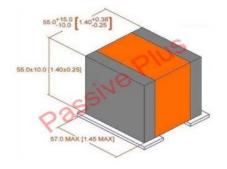
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Capacitor Application Program

Passive Plus, Inc.'s brand new **online Capacitor Application Program** (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models, by either visiting the <u>Passive Plus Resources page</u> (<u>http://passiveplus.com/addldocs_resources.php</u>).

#Modelithics®



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Recommended Land Pattern Dimensions

When mounting the capacitor to substrate, it's important to carefully consider that the amount of solder (size of fillet) used has a direct effect upon the capacitor once it's mounted.

1) The greater the amount of solder, the greater the stress to the elements. This may cause the substrate to break or crack.

2) In the situation where two or more devices are mounted onto a common land, be sure to separate the device into exclusive pads by using soldering resist.

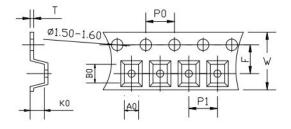
+ Horizontal Mounting Dimensions: mm



| 茾 Vertical N | Mounting | Dimensions: mm |
|--------------|----------|----------------|
| Α | В | С |
| 1.90 | 1.70 | 2.50 |

Tape & Reel Specifications Dimensions: mm

Horizontal Orientation

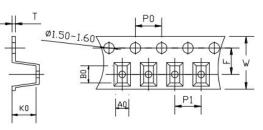


| Orientation | A0 | B0 | K0 | W | PO | P1 | Т | F | Qty Min | Qty/ reel | Tape Material |
|-------------|------|-----------|------|-------|------|------|-------|------|---------|--------------|------------------|
| Horizontal | 2.92 | 3.51 | 2.34 | 8.00 | 4.00 | 4.00 | 0.254 | 3.50 | 500 | 500 | Embossed |
| Vertical | 2.92 | 3.51 | 2.34 | 12.00 | 4.00 | 4.00 | 0.254 | 3.50 | 500 | 500 | Embossed |

Dimensions: mm



Vertical Orientation



PPP Passive Plus Inc. RF & Microwave Components

1111N (0.110" x 0.110"





EIA Low ESR Multi-Layer Ceramic Capacitors

1111N (0.110" x 0.110")

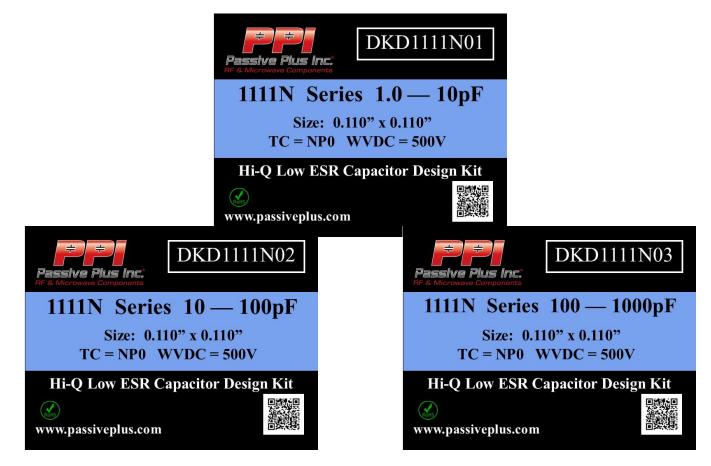
🗧 Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are 100% RoHS compliant.



| Kit Number | Value Range | Values | |
|------------|----------------|---|------|
| DKD1111N01 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF | Roms |
| DKD1111N02 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF | Roms |
| DKD1111N03 | 100 - 1000pF | 100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000pF | RoHS |













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Engineering Design Kits

According to the customer's demand, PPI can provide many kinds of tool kits for engineers to design and debug the circuit. All of our products satisfy the requirement of RoHS instruction.

PPI also offers kits for Non-Magnetic MRI applications. Engineering design kits are also available in multiple sizes as well. All kits are RoHS Compliant.

Standard Values updated in 2022.



www.passiveplus.com

| | Kit N MAGNETIC | umber NON-MAGNETIC | Value Range | Values |
|---|-------------------|-----------------------|----------------|---|
| | DKD0505C01 | DKD0505C05 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF |
| _ | DKD0505P01 | DKD0505P05 | 0.1 - 2.0pr | 0.1, 0.2, 0.5, 0.1, 0.5, 0.0, 0.7, 0.0, 0.7, 1.0, 1.0, 1.0, 1.0, 1.0, 1.0, 2.0pr |
| | DKD0505C02 | DKD0505C06 | 1 10mE | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF |
| | DKD0505P02 | DKD0505P06 | 1 - 10pF | 1.0, 1.2, 1.3, 1.0, 2.0, 2.2, 2.4, 2.7, 5.0, 5.5, 5.9, 4.7, 5.0, 0.8, 8.2, 10pr |
| | DKD0505C03 | DKD0505C07 | 10 100-E | 10 12 15 10 20 22 24 27 20 22 20 47 5((0 02 100 F |
| | DKD0505P03 | DKD0505P07 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF |
| | DKD0505C04 | DKD0505C08 | 100 - 1000pF | 100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000pF |
| | | | | |
| _ | DKD1111C01 | DKD1111C05 | 1.0.10mE | 10 12 15 18 20 22 24 27 20 22 20 47 56 68 82 10mE |
| | DKD1111P01 | DKD1111P05 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF |
| | DKD1111C02 | DKD1111C06 | 10 100mE | 10 12 15 19 20 22 24 27 20 22 20 47 56 69 82 100-E |
| | DKD1111P02 | DKD1111P06 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF |
| | DKD1111C03 | DKD1111C07 | 100 1000 E | |
| | DKD1111P03 | DKD1111P07 | 100 - 1000pF | 100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000pF |
| | DKD1111C04 | DKD1111C08 | 1000 10000-F | 1000, 1100, 1200, 1500, 1800, 2000, 2200, 2700, 3000, 3300, 3900, 4700, 5100, |
| | DKD1111P04 | DKD1111P08 | 1000 - 10000pF | 5600, 10000pF |
| | | | | |



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Engineering Design Kits

| EIA Low ESI Kit Number | R Design Kits Value Range | Values |
|---------------------------|---------------------------------|---|
| DKD0201N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.5, 0.7, 0.8, 0.9, 1.0, 1.3, 1.5, 1.7, 1.9, 2.0pF |
| DKD0201N02 | 1.0 - 10pF | 1.0, 1.3, 1.5, 1.7, 1.9, 2.0, 2.2, 2.7, 3.0, 3.9, 4.7, 5.6, 6.8, 7.5, 8.2, 10pF |
| DKD0201N03 | 10 - 100pF | 10, 13, 15, 18, 20, 22, 27, 30, 39, 47, 56, 68, 75, 82, 91, 100pF |
| DKD0402N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF |
| DKD0402N02 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF |
| DKD0402N03 | 10 - 33pF | 10, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33pF |
| DKD0603N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.1, 1.2, 1.5, 1.6, 1.8, 2.0pF |
| DKD0603N02 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF |
| DKD0603N03 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 100pF |
| DKD0805N01 | 0.1 - 2.0pF | 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF |
| DKD0805N02 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF |
| DKD0805N03 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF |
| DKD0805N04 | 10 - 220pF | 10, 15, 18, 20, 24, 27, 30, 39, 47, 56, 68, 82, 100, 120, 150, 180, 220pF |
| DKD1111N01 | 1.0 - 10pF | 1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF |
| DKD1111N02 | 10 - 100pF | 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF |
| DKD1111N03 | 100 - 1000pF | 100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820 1000pF |
| | 1 | |

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Custom Kits

According to the customer's demand, PPI can provide many kinds of tool kits for engineers to design and debug the circuit. All our products satisfy the requirement of RoHS instruction.

Passive Plus will develop a custom kit using the engineer's specific requirements for the engineer's projects (case size, temperature coefficient, value range, tolerances, voltages, and quantities per value). Once these requirements are determined, PPI will then provide customer with a price. Please contact PPI directly to start this process.

All kits are RoHS Compliant.









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Custom Kits













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0505X (0.055" x 0.055")



Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 470pF to 10000pF

† Product Applications

Typical Functional Applications:

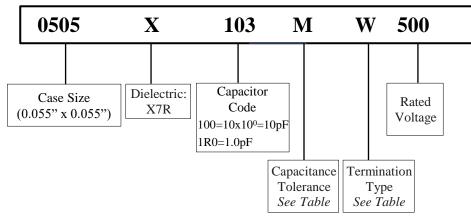
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications:

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



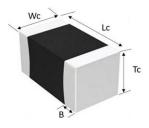
Part Numbering



÷ Capacitor Dimensions

Unit: inch (millimeter)

| Length | Width | Thickness | Overlap |
|--|--|---------------------|---|
| Lc | Wc | Tc | В |
| 0.055 + 0.015 to -0.010 (1.40 +0.38 to -0.25) | $\begin{array}{c} 0.055 \pm .010 \\ (1.40 \pm 0.25) \end{array}$ | 0.057 (1.45 max) | $\begin{array}{c} 0.014 \pm 0.006 \\ (0.356 \pm 0.152) \end{array}$ |







0505X (0.055" x 0.055")

÷ 0505X Capacitance Values

| Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | Rated WVDC |
|---------|-------------|------|---------------|---------|-------------|------|---------------|---------|-------------|------|---------------|
| 470 | 471 | | | 1500 | 152 | | | 4700 | 472 | | |
| 560 | 561 | | | 1800 | 182 | | | 5000 | 502 | | |
| 680 | 681 | K,M | 50V | 2200 | 222 | K,M | 50V | 5600 | 562 | K,M | 50V |
| 820 | 821 | | | 2700 | 272 | | | 6800 | 682 | , | |
| 1000 | 102 | | | 3300 | 332 | | | 8200 | 822 | | |
| 1200 | 122 | | | 3900 | 392 | | | 10000 | 103 | | |

Special capacitances, tolerances and WVDC are available. Please contact PPI.

÷ Capacitance Tolerance Codes

† Termination Types

| Code K M | Termination Code | Plated Material |
|---------------------------------------|--|---------------------|
| Tol. ±10% ±20% | W | Sn/Ni |
| | L | 90% Sn10%Pb |
| | P (Non-Magnetic) | Sn/Cu |
| | С | Ag/Pb |
| | G | Au/Ni |
| Electrical Specifications | Note: "Non-Magnetic" means no | magnetic materials. |
| Operating Temperature Range | -55°C to +125°C | |
| Insulation Resistance (IR) | Insulation Resistance @ - Insulation Resistance @ - | |
| Temperature Voltage Coefficient | +15/-25% ΔC (-55°C to - | -125°C) |
| Dielectric Withstanding Voltage (DWV) | 2.5x WVDC, 5 seconds | |

0.025 (2.5%) max

1kHz, 1.0 VRMS, 25°C

Test Parameters

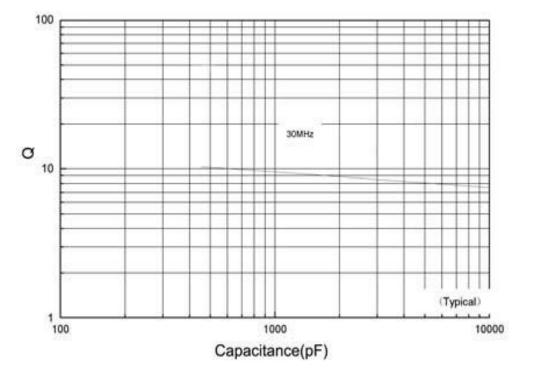
Max Dissipation Factor



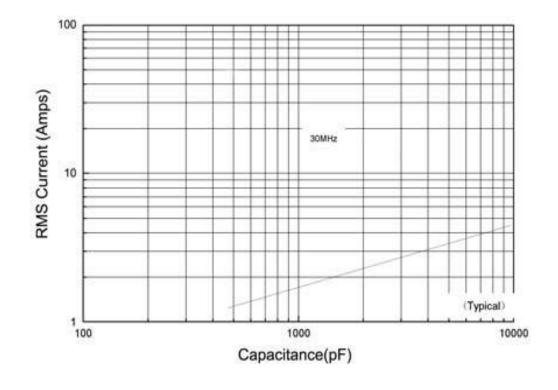


0505X (0.055" x 0.055")

‡ Q vs. Frequency







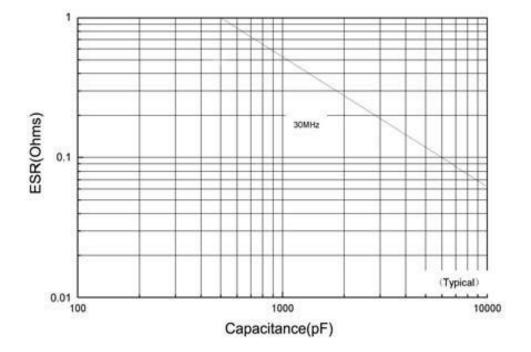


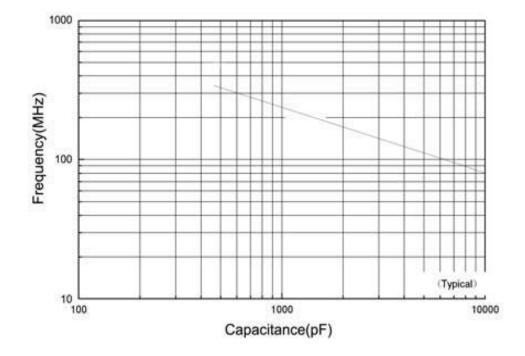
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0505X (0.055" x 0.055")

ESR vs Capacitance







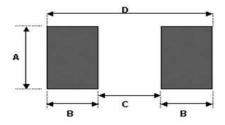
sales@passiveplus.com PPI0505XData111521RevA



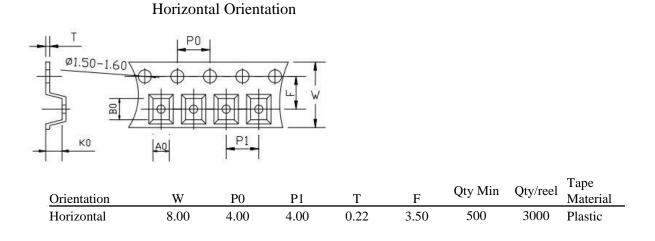
0505X (0.055" x 0.055")

+ Mounting Pad Recommendations

| Orientation | A Min | B Min | C Min | D Min |
|-------------|----------|----------|----------|----------|
| Vertical | 0.070" | 0.050" | 0.030" | 0.130" |
| Horizontal | 0.080" | 0.050" | 0.030" | 0.130" |



Tape & Reel Specifications (mm)



$A_0 B_0 K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .05 (.002) min to .50 (.020) max for 8mm tape and .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.





Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 4700pF to 100nF

+ Product Applications

Typical Functional Applications:

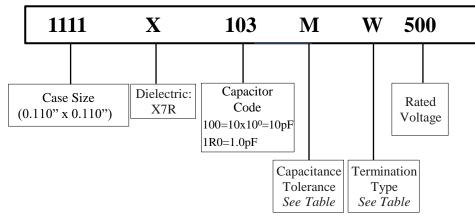
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

Typical Circuit Applications:

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



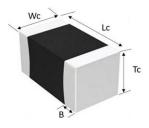
Part Numbering



÷ Capacitor Dimensions

Unit: inch (millimeter)

| Length | Width | Thickness | Overlap |
|---------------------------------------|---|---------------------|---|
| Lc | Wc | Tc | В |
| 0.110+0.025~010 (2.79+0.64~ -0.25) | 0.110 ± 0.015 (2.79 ± 0.38) | 0.102 (2.59 max) | $\begin{array}{c} 0.020 \pm 0.010 \\ (0.508 \pm 0.250) \end{array}$ |





1111X (0.110" x 0.110")

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11111X (0.110" x 0.110")

≠ 1111X Capacitance Values

| Cap. pF | Cap Code | Tol. | Rated WVDC | Cap. pF | Cap Code | Tol. | <u>Rated</u> WVDC | Cap. pF | Cap Code | Tol. | <u>Rated</u> WVDC |
|---------|-------------|------|---------------|---------|-------------|------|----------------------|------------|-------------|------|----------------------|
| 4700 | 472 | | | 15000 | 153 | | | 47000 | 473 | | |
| 5600 | 562 | | | 18000 | 183 | | | 50000 | 503 | | |
| 6800 | 682 | K,M | 50V | 22000 | 223 | K,M | 50V | 56000 | 563 | K,M | 50V |
| 8200 | 822 | | 501 | 27000 | 273 | | 301 | 68000 | 683 | | 501 |
| 10000 | 103 | | | 33000 | 333 | | | 82000 | 823 | | |
| 12000 | 123 | | | 39000 | 393 | | | 100000 | 104 | | |

Special capacitances, tolerances and WVDC are available. Please contact PPI.

÷ Capacitance Tolerance Codes

† Termination Types

| Code K M | Termination Code | Plated Material |
|---------------------------------------|---|---------------------|
| Tol. ±10% ±20% | W | Sn/Ni |
| | L | 90% Sn10%Pb |
| | P (Non-Magnetic) | Sn/ Cu |
| | С | Ag/Pb |
| | G | Au/Ni |
| Electrical Specifications | Note: "Non-Magnetic" means no | magnetic materials. |
| Operating Temperature Range | -55°C to +125°C | |
| Insulation Resistance (IR) | Insulation Resistance @ Insulation Resistance @ | |
| Temperature Voltage Coefficient | +15/-25% ΔC (-55°C to - | +125°C) |
| Dielectric Withstanding Voltage (DWV) | 2.5x WVDC, 5 seconds | |

0.025 (2.5%) max

1kHz, 1.0 VRMS, 25°C

Test Parameters

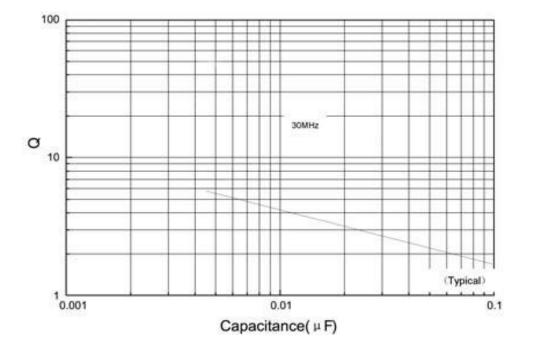
Max Dissipation Factor



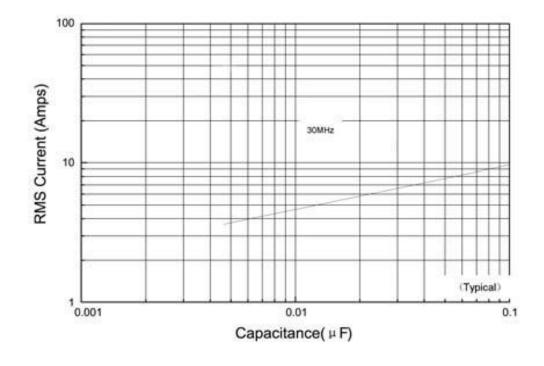


1111X (0.110" x 0.110")

† Q vs. Frequency



÷ Current Rating vs. Capacitance



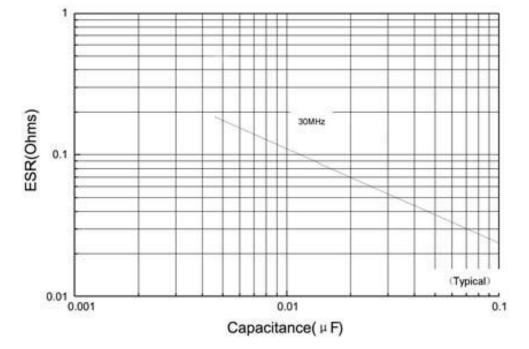


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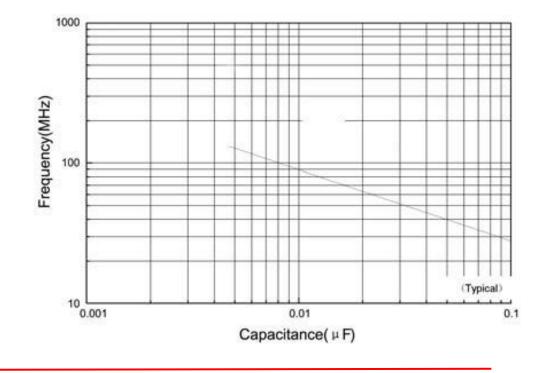


1111X (0.110" x 0.110")

ESR vs Capacitance



÷ Series Resonance vs. Capacitance



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PPI1111XData111521RevA

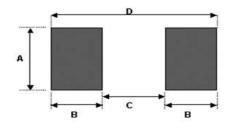




1111X (0.110" x 0.110")

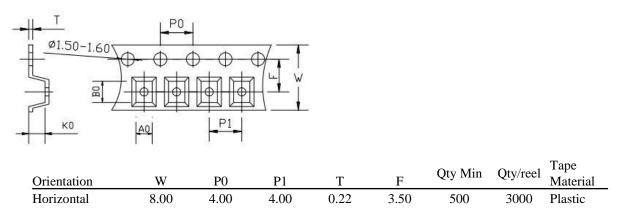
Mounting Pad Recommendations

| Orientation | A Min | B Min | C Min | D Min | | |
|-------------|----------|----------|----------|----------|--|--|
| Vertical | 0.120" | 0.050" | 0.075" | 0.175" | | |
| Horizontal | 0.130" | 0.050" | 0.075" | 0.175" | | |



+ Tape & Reel Specifications (mm)





 $A_0\,B_0\,K_0$

- Determined by component size. Typical clearance between the cavity and the component is: 0.5(0.02) is 1.50(0.02) is 1.50(0.02) is 1.50(0.02) is 1.50(0.02)
- .05 (.002) min to .50 (.020) max for 8mm tape and .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.



2225X (0.220" x 0.250"



Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 10nF to 1µF

÷ Product Applications

Typical Functional Applications:

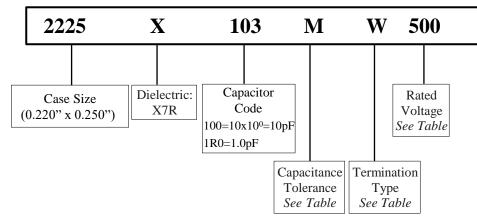
- Tuning Bypass Coupling
- D.C. Blocking Impedance Matching

Typical Circuit Applications

- UHF/Microwave RF Power Amplifiers
- Antenna Tuning Plasma Chambers
- Medical Equipment



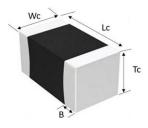
茾 Part Numbering



÷ Capacitor Dimensions

Unit: inch (millimeter)

| Length | Width | Thickness | Overlap | | |
|---|---|---------------------|---|--|--|
| Lc | Wc | Tc | В | | |
| 0.230+.020 ~ -0.012 (5.84+0.51~ -0.30) | 0.250 ± 0.015 (6.35 ± 0.38) | 0.165 (4.19 max) | $\begin{array}{c} 0.030 \pm 0.015 \\ (0.762 \pm 0.380) \end{array}$ | | |







2225X (0.220" x 0.250")

2225X Capacitance Values

| Cap. uF | Cap Code | Tol. | Rated WVDC | Cap. uF | Cap Code | Tol. | Rated WVDC | Cap. uF | Cap Code | Tol. | Rated WVDC | |
|------------|-------------|-------|---------------|------------|-------------|--------|---------------|------------|-------------|------|---------------|------|
| 0.010 | 103 | | | 0.082 | 823 | | | 0.560 | 564 | K,M | 150V | |
| 0.012 | 123 | | K,M | 300V | 0.100 | 104 | | | 0.680 | 684 | 17,191 | 1500 |
| 0.015 | 153 | 1,111 | 5000 | 0.120 | 124 | к,М | 200V | 0.820 | 824 | K,M | 100V | |
| 0.022 | 223 | | | 0.150 | 154 | | | 1.000 | 105 | | 1001 | |
| 0.033 | 333 | | | 0.220 | 224 | | | | | | | |
| 0.047 | 473 | K,M | 250V | 0.330 | 334 | K,M | K.M 150V | | | | | |
| 0.068 | 683 | | | 0.470 | 474 | 17,101 | 100 | | | | | |

Special capacitances, tolerances and WVDC are available. Please contact PPI.

| ÷ | Capacitance Tolerance Codes | | | | | pes | | ge s | | |
|--------------|--------------------------------|----------|-----------|---------|---------------------|-----------------------|---------------------------------------|---------|---------|------|
| | Code | K | Μ | | Termination Code | | Plated Material | | Voltage | Code |
| | Tol. | ±10% | ±20% | | W | | Sn/Ni | ROHS | 100V | 101 |
| | | | | | L | | 90% Sn10%Pb | | 150V | 151 |
| | | | | | P (Non-Magnetic) | \bigotimes | Sn/ Cu | ROHS | 200V | 201 |
| | | | | | С | | Ag/Pb | | 250V | 251 |
| | | | | | G | | Au/Ni | RoHS | 300V | 301 |
| ; | Electric Operatin | - | | | -55 | $^{\circ}$ C to +125° | С | | | |
| | Insulatio | n Resist | ance (IR |) | | | stance @ +25°C > stance @ +125°C > | | | |
| | Tempera | ture Vol | tage Coe | efficie | ± 13 | 5% Maximu | m | | | |
| | Dielectri | c Withst | tanding V | Voltag | ge (DWV) 2.52 | WVDC, 5 | seconds | | | |
| | Max Dis | sipation | Factor | | 0.02 | 25 (2.5%) m | ax | | | |
| | Test Para | ameters | | | 1kH | Iz, 1.0 VRM | IS. 25°C | | | _ |



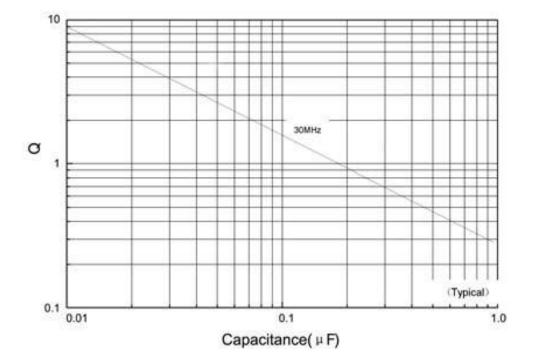
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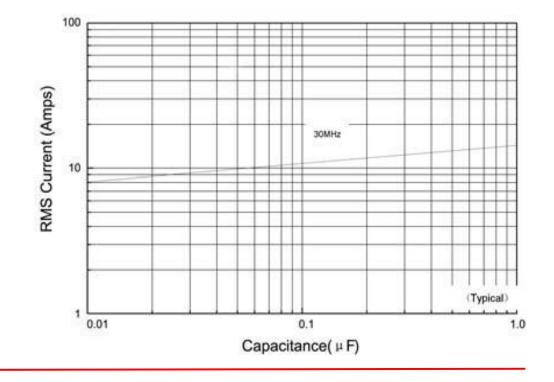


2225X (0.220" x 0.250")

‡ Q vs. Frequency



÷ Current Rating vs. Capacitance

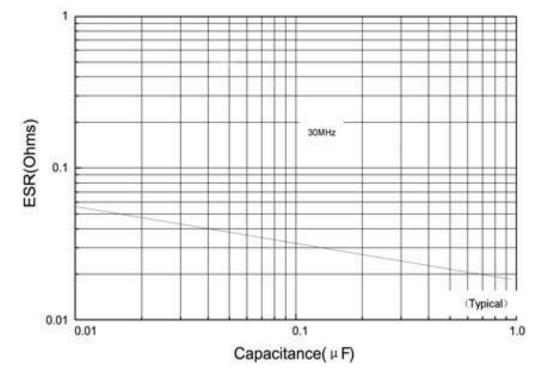




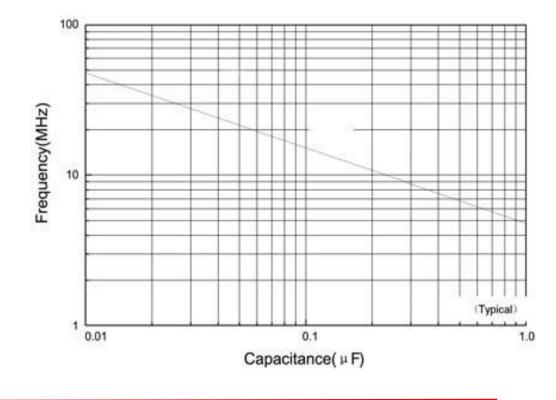


2225X (0.220" x 0.250")

ESR vs Capacitance







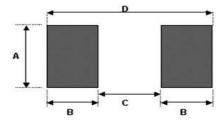




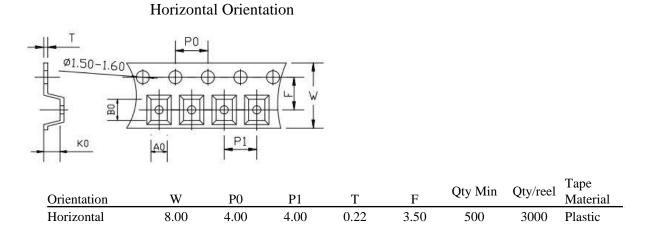


Mounting Pad Recommendations

| Orientation | A | B | C | D | |
|-------------|--------|--------|--------|--------|--|
| | Min | Min | Min | Min | |
| Horizontal | 0.280" | 0.050" | 0.200" | 0.300" | |



+ Tape & Reel Specifications (mm)



$A_0\,B_0\,K_0$

• Determined by component size. Typical clearance between the cavity and the component is:

.05 (.002) min to .50 (.020) max for 8mm tape and .50 (.002) min to .65 (.026) max for 12mm tape.

• The component cannot rotate more than 20° within the determined cavity.





Hand Soldering Chip Capacitors

Among the most common reasons multilayer ceramic chip capacitors (MLCCs) fail is improper hand soldering to printed circuit boards. Typically, one or more hairline cracks develop in the ceramic, defects that may even have an imperceptible effect on initial performance, but that manifest with time, circuit board flexure, or temperature excursions. Herein are a few tips, suggestions, and caveats to be aware of in performing a reliable hand soldering attachment.

<u>Solders</u>. Before selecting a solder, one should know the metallization on the chip. Starting at the component ceramic surface from which the electrodes protrude (typically < 1 mil), a contacting "termination" is applied that most often contains silver (Ag) or nickel (Ni). Over this is plated a barrier metal, typically nickel or copper (for non-magnetic applications), followed by a finishing metallization of tin (Sn) or lead (Pb)-tin. Other finishes may include palladium- silver (Pd/Ag), Ag, or gold (Au).

For finishes that include Ag, a silver bearing solder such as Sn62 is recommended to combat leaching of the component's silver into the solder joint. Silver bearing solders also improve resistance to thermal fatigue. For finishes that include Au, a solder such as In50 is suggested to avoid gold scavenging that may cause embrittlement (which occurs when gold comprises approximately 3% or greater by weight of the solder joint). For finishes that do not contain noble metals, SN63 is often used, or Sn95.5 or Sn96 where there is a no-lead, e.g. ROHS, requirement.

<u>Fluxes</u>. An appropriate flux helps to clean the surfaces to be soldered and facilitates solder spread; it may also remove oxidation. Check with the solder manufacturer for a recommended flux. Rosin based fluxes are most common but require post solder cleaning.

Fluxes are available both separately as pastes and as internal cores within wire solder. Each form has advantages and disadvantages. Use of an external flux permits precise placement in exact quantities, but consideration must be given to the activation temperature of the flux, which will be lower than that of the solder liquidus, and the time spent at this temperature. Too long at the latter will result in boiling off the flux and reducing its effectiveness. Flux core solder is easy and convenient to use but may require more solder than desirable to have sufficient flux for good coverage.

In practice, external flux seems to work best for parts of size 0603 or 0505 and below, while flux core solder appears satisfactory for larger component sizes.

<u>Soldering iron</u>. A temperature-controlled iron of suitable wattage is strongly recommended. The iron temperature should typically be set 20-30°C above the solder liquidus temperature. Tip size is important; it should be about the same size as the part. Too small a tip (corresponding to an iron of insufficient wattage) will take too long to heat the printed circuit board land and part, while too large a tip (too high a wattage iron) may damage the board or component.





† Soldering Procedure

The initial consideration is which end of the capacitor to solder first. The choice can generally be decided by recognizing that it is desirable to minimize the heat flowing directly through the component. Thus, it is best to start from the end that has the poorest heat conduction (equals highest thermal resistance) to a heat sink. (Were one to start from the opposite end, a good heat path would have been created <u>through</u> the capacitor to the heat sink when one soldered the second joint.) If it is not apparent which land has the poorer connection to a heat sink, begin with the one having the smallest area.

Follow these steps in soldering:

1. <u>Pre-heat the substrate</u>. Where possible, it is very desirable to gradually pre-heat the substrate, e.g. on a hotplate, to about 30°C below the solder liquidus temperature. Two steps are usually sufficient: Start the hotplate at a temperature about halfway to the desired pre-heat temperature, place the board on it and wait till the board temperature stabilizes, then increase the hotplate temperature to the desired final pre-heat value.

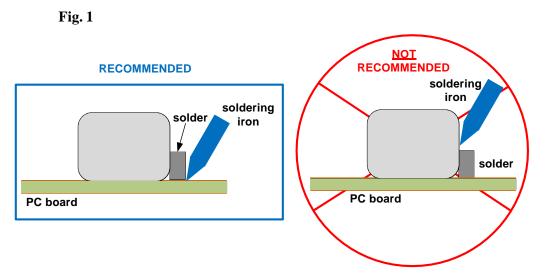
2. <u>Pre-" tin" the traces.</u> Select one of the PC board lands and clean it with isopropyl alcohol. If the solder you are using does not contain its own flux, place a small quantity of flux on the land, and a small amount of solder into the flux. (A razor may be used to cut a tiny custom preform from solid wire.) Place the iron on the printed circuit trace adjacent to the flux (but not touching) and heat the land until the solder melts into a flat, shallow pool. Remove the iron, then clean off any remaining flux with isopropyl alcohol. Repeat the procedure for the second land, then add fresh flux and a fresh solder preform (if not using flux-core solder) to each tinned land. (The preform should have sufficient mass to create a proper fillet – see step 5 – on the component.)

3. Pick up the component with either a hand tweezer or vacuum tweezer. (Stainless steel or ceramic-tipped tweezers are preferred.)

4. Place the component so that it straddles the circuit board lands, and make sure it lies flat on the board. As shown in **Fig. 1**, **Do not touch the component directly with the soldering iron**. Rather, touch the iron to the land adjacent to the capacitor until the solder begins to flow; then move the iron slowly toward the component.

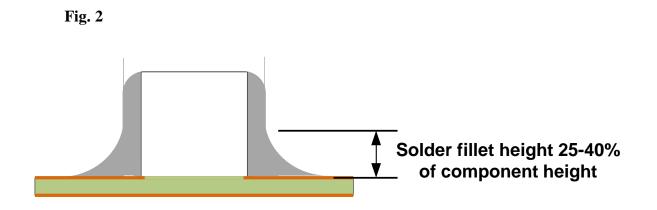






5. When a fillet forms, remove the iron. As shown in **Fig. 2**, solder fillets should occupy about 25-40% of the component's height, have a concave profile, and be free of peaks and voids.

6. Repeat steps 1-5 for the second joint, then let the board cool gradually to room temperature. Use isopropyl alcohol to remove any residual flux from each joint.





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+ Wave Soldering

When sudden heat is applied to the elements, the mechanical strength of the components should decrease because remarkable temperature change can cause deformity of components inside. Also, long soldering time or high soldering temperatures, result in leaching by the external electrodes, causing poor adhesion or a reduction in capacitance value due to loss of contact between electrodes and end termination.

In order to avoid mechanical damage in the elements, preheating should be requested for both of the components and the PCB board. Preheating conditions are given in the table below. It is requested to keep the temperature gap between the soldering and the elements surface (.T) as small as possible.

When elements are submerged in solvent after mounting, be sure to maintain the temperature gas (.T) between the element and solvent within the range shown in the table below.

Do not apply the flow soldering to capacitors not listed in the table below.

| Chip Capacitor | 01005/0201/0402/0603/0505/0805 |
|----------------|--------------------------------|
| Preheating | ∆T≤150°C |

PPI does not recommend flow soldering for its 1111P/1111C, 2225P/2225C, 3838P/3838C.



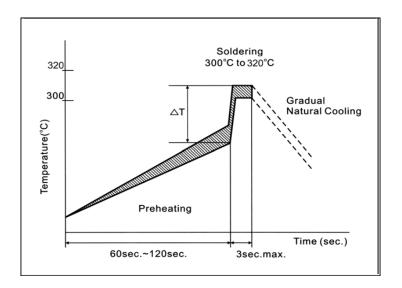
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≠ Soldering Iron

When sudden heat is given to the elements by soldering iron, the mechanical strength of the components should weaken because sharp temperature change can cause deformity of components inside. In order to avoid mechanical damage in the elements, preheating should be requested for both of the components and the PCB board. Preheating conditions are given in the below table. It is requested to keep the temperature gap between the soldering and the elements surface (ΔT) as small as possible. After the soldering, it should not be allowed to cool down suddenly.



| Size | Soldering Iron | Temperature | Soldering Iron head Size | Solder |
|-----------|----------------------|-------------|--------------------------|------------------------|
| 0505/0805 | | 330°C | | |
| 1111 | 70W Thermostat Iron | 350°C | | 63Sn/37Pb, |
| 2225 | 70 w Thermostat from | 370°C | | 95.5Sn/3.8Ag /0.7Cu |
| 3838 | | 370°C | | |

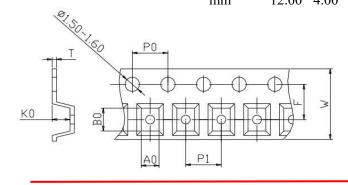




High-Q Low ESR Capacitors

High-Q Low ESR Capacitor Tape & Reel Specifications

| | Orientation | Measurement Unit | W | P0 | P1 | Т | F | Minimum Qty per Reel | Std Qty per Reel | Tape Materia |
|------------|-------------|---------------------|----------------|---------------|----------------|---------------|---------------|----------------------------|---------------------|-----------------|
| 0201N | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.079 2.00 | 0.017 0.42 | 0.138 3.50 | 1000 | 15000 | Paper |
| 0402N | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.079 2.00 | 0.003 0.07 | 0.138 3.50 | 1000 | 10000 | Paper |
| 0603N | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | 0.004 0.10 | 0.138 3.50 | 500 | 4000 | Paper |
| 00051 | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | | 0.138 3.50 | 500 | 3000 | Plastic |
| 0805N • | V | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | 0.009 0.22 | 0.138 3.50 | 500 | 1000 | Plastic |
| 11111 | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | 0.010 0.25 | | 500 | 2000 | D14' |
| 1111N - | V | in. mm | 0.472 12.00 | 0.157 4.00 | 0.157 4.00 | 0.016 0.40 | 0.217 5.50 | 500 | 1500 | - Plastic |
| 0.505 GD | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | 0.009 0.22 | | 500 | 3000 | |
| 0505CP - | V | in. mm | 0.472 12.00 | 0.157 4.00 | 0.157 4.00 | 0.012 0.30 | 0.217 5.50 | 500 | 2000 | Plastic |
| | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | 0.009 0.22 | 0.138 3.50 | 500 | 2000 | |
| 1111CP | P V | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | 0.009 0.22 | 0.138 3.50 | 500 | 1500 | Plastic |
| - | V | in. mm | 0.472 12.00 | 0.157 4.00 | 0.157 4.00 | 0.016 0.40 | 0.217 5.50 | 500 | 1500 | |
| 2225 C.D. | Н | in. mm | | | 0.472 12.00 | 0.012 0.30 | | 500 | 500 | Plastic |
| 2225CP - | V | in. mm | 0.630 16.00 | 0.157 4.00 | 0.315 8.00 | 0.020 0.50 | 0.295 7.50 | 500 | 500 | Plastic |
| 3838CP | Н | in. mm | 0.630 16.00 | | 0.630 16.00 | | | 50 | 200 | Plastic |
| 0505X | Н | in. mm | 0.315 8.00 | 0.157 4.00 | 0.157 4.00 | 0.012 0.30 | | 500 | 4000 | Plastic |
| 1 1 1 1 37 | Н | in. | | | 0.157 4.00 | 0.012 0.30 | | 500 | 2000 | Plastic |
| 1111X | | mm | 0.00 | | | | | | | |



$A_0B_0K_0$

• Determined by component size. Typical clearance between the cavity and the component is:

.50 (.002) min to .65 (.026) max for 12mm tape.

 \bullet The component cannot rotate more than 20° within the determined cavity.



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Marking shown for illustration purposes only. Actual marking may differ.



